

January 2011

Dear Tyco Electronics Customer:

In response to your inquiry regarding Tyco Electronics' activities relative to **REACH**, the European Union Regulation concerning the Registration, Evaluation, and Authorisation of Chemicals, please be advised of the following:

#### Awareness and focus

Tyco Electronics is fully aware of the European REACH regulation and has dedicated programs and resources to deal with all legislative requirements and business continuity concerns related to REACH.

#### Registration of Substances

Although Tyco Electronics is principally a supplier of articles which do not require registration, we have completed the process of contacting our suppliers of "substances, preparations, and articles" to ensure that all necessary pre-registration/registration requirements are being complied with in the required timescales. This effort extends to all materials used by Tyco Electronics that are within the scope of REACH and with regard to the applications in which the materials are used in our products. Tyco Electronics is engaged in the registration process for those few substances where we are either manufacturer or importer.

#### Ongoing supply of our products

As a result of the above mentioned efforts, we expect that REACH will not interfere with the supply of materials used in Tyco Electronics' products and that there will be no interruption in the supply of Tyco Electronics' products to our customers.

#### Substances of Very High Concern (SVHCs)

In **October 2008** the European Chemical Agency (ECHA) published a first list of 15 substances that are under consideration for inclusion in Annex XIV as Substances of Very High Concern. We have essentially completed the assessment of our products against this list and have found that the vast majority do not contain any of these SVHCs. We have added this October 2008 REACH "compliance" information to our Statements of Compliance for our products which can be found on the website below.

In **January 2010**, ECHA has published a second list of 14 substances that are also under consideration for inclusion in Annex XIV as Substances of Very High Concern. In **March 2010**, a single additional substance was added. We have largely completed our assessment of these 15 substances with no products identified as containing any of these substances to date. We have added this Jan/Mar 2010 REACH "compliance" information to our Statements of Compliance for our products which can be found on the website below.

In **June 2010**, ECHA published a list of 8 substances that are also under consideration for inclusion in Annex XIV as Substances of Very High Concern. Our initial assessment indicates that these substances are not contained in any TE products. We have added this June 2010 REACH "compliance" information to our Statements of Compliance for our products which can be found on the website below.

In **December 2010**, ECHA published a list of 8 substances that are also under consideration for inclusion in Annex XIV as Substances of Very High Concern. Our initial assessment indicates that these substances are not contained in any TE products. We have added this December 2010 REACH "compliance" information to our Statements of Compliance for our products which can be found on the website below.

*Be assured that, if any Substance of Very High Concern is identified in any of our products above the threshold of 0.1% by weight, Tyco Electronics will take necessary actions to make the required **notification** to our customers.*



#### Annex XVII Restrictions

In June 2009 ECHA amended Annex XVII of REACH, consolidating a number of existing restrictions that had been implemented as amendments to Directive 76/769/EEC. Tyco Electronics was in compliance with these regulations previously and we remain compliant to the current Annex XVII restrictions. (Note that in many cases these restrictions are application specific and our statement of compliance is based on our understanding that our products are not used in these restricted applications.) We will continue to monitor any new additions to Annex XVII and will update our compliance statement as appropriate. Should you require more detailed information regarding use of our products in any restricted applications, please use the website indicated below.

For additional information regarding Tyco Electronics Product Compliance initiatives, please visit our Customer Support Center at [www.tycoelectronics.com/customersupport/rohssupportcenter](http://www.tycoelectronics.com/customersupport/rohssupportcenter) .

Should you have any further questions, do not hesitate to contact your Tyco Electronics Sales Engineer.

David R. Bender  
Director, Product Compliance  
Tyco Electronics



## Statement of Compliance

### Requested Part

05 September 2012

183635-3

( Part 1 of 1)

INSERT CAT5E 2x ISDN /B

Status: Active

EU RoHS/ELV Code: 5 of 6 EU RoHS/ELV Compliant

Solder Process Capability Code: Not applicable for solder process capability

China RoHS:  Restricted Materials Above Threshold

Exemptions: 7(x) - Pb-Used for ELV, 5/6 parts

REACH Oct 2008 SvHC Compliance: Not reviewed for REACH October 2008 SvHC(s)

REACH Jan/Mar 2010 SvHC Compliance: Not reviewed for REACH Jan/Mar 2010 SvHC(s)

REACH June 2010 SvHC Compliance: Contains no REACH June 2010 SvHC(s)

REACH Dec 2010 SvHC Compliance: Contains no REACH December 2010 SvHC(s)

REACH June 2011 SvHC Compliance: Not reviewed for REACH June 2011 SvHC(s)

REACH December 2011 SvHC Compliance: Not reviewed for REACH December 2011 SvHC(s)

REACH June 2012 SvHC Compliance: Not reviewed for REACH June 2012 SvHC(s)

Halogen Content: Not Yet Reviewed for halogen content

David R. Bender

Director, Product Compliance

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The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hex chrome, mercury, PBB, PBDE, and 0.01% for cadmium, or qualify for an exemption to above limits as defined in the Annex of the EU RoHS Directive. Note that any exemptions taken in this case would not include application specific exemptions (e.g. lead in solder for servers) as TE cannot determine where component products will be used.

Additionally, the part numbers that are identified as 5 of 6 compliant meet the material limits described above, except that these products have lead in the solderable interface only. These products may be suitable for use in an application that has an exemption for the use of lead in solder (e.g. servers, network infrastructure, etc).

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information provided by our suppliers. This information is subject to change.



05 September 2012

中国电子信息产品环境信息  
China EIP Environmental Information



Restricted Materials Above Threshold

电子元件 (Electronic Component) 183635-3	有毒有害物质或元素 Hazardous Substance					
	铅 (Pb)	汞 (Hg)	镉 (Cd)	六价铬 (Cr6)	多溴联苯 (PBB)	多溴二苯醚 (PBDE)
电子元件 (Electronic Component)	X	O	O	O	O	O
<p>O: 表示该部件内有有毒有害物质含量在 SJ/T 11363-2006 标准规定的限量要求以下 Indicates that the concentration of the hazardous substance in the part is below the relevant threshold of the SJ/T 1136 3-2006 standard.</p> <p>X: 表示该部件内有有毒有害物质含量超出 SJ/T 11363-2006 标准规定的限量要求 Indicates that the concentration of the hazardous substance in the part is above the relevant threshold of the SJ/T 1136 3-2006 standard.</p>						

Description for part 183635-3:

INSERT CAT5E 2x ISDN /B

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## Statement of Compliance

### Requested Part

05 September 2012

183636-3


( Part 1 of 1)

INSERT CAT5E 2x 10/100BT /B

Status: Active

EU RoHS/ELV Code: 5 of 6 EU RoHS/ELV Compliant

Solder Process Capability Code: Not applicable for solder process capability

China RoHS:  Restricted Materials Above Threshold

Exemptions: 7(x) - Pb-Used for ELV, 5/6 parts

REACH Oct 2008 SvHC Compliance: Not reviewed for REACH October 2008 SvHC(s)

REACH Jan/Mar 2010 SvHC Compliance: Not reviewed for REACH Jan/Mar 2010 SvHC(s)

REACH June 2010 SvHC Compliance: Contains no REACH June 2010 SvHC(s)

REACH Dec 2010 SvHC Compliance: Contains no REACH December 2010 SvHC(s)

REACH June 2011 SvHC Compliance: Not reviewed for REACH June 2011 SvHC(s)

REACH December 2011 SvHC Compliance: Not reviewed for REACH December 2011 SvHC(s)

REACH June 2012 SvHC Compliance: Not reviewed for REACH June 2012 SvHC(s)

Halogen Content: Not Yet Reviewed for halogen content

David R. Bender

Director, Product Compliance

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The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hex chrome, mercury, PBB, PBDE, and 0.01% for cadmium, or qualify for an exemption to above limits as defined in the Annex of the EU RoHS Directive. Note that any exemptions taken in this case would not include application specific exemptions (e.g. lead in solder for servers) as TE cannot determine where component products will be used.

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05 September 2012

中国电子信息产品环境信息  
China EIP Environmental Information



Restricted Materials Above Threshold

电子元件 (Electronic Component) 183636-3	有毒有害物质或元素 Hazardous Substance					
	铅 (Pb)	汞 (Hg)	镉 (Cd)	六价铬 (Cr6)	多溴联苯 (PBB)	多溴二苯醚 (PBDE)
电子元件 (Electronic Component)	X	O	O	O	O	O
<p>O: 表示该部件内有有毒有害物质含量在 SJ/T 11363-2006 标准规定的限量要求以下 Indicates that the concentration of the hazardous substance in the part is below the relevant threshold of the SJ/T 1136 3-2006 standard.</p> <p>X: 表示该部件内有有毒有害物质含量超出 SJ/T 11363-2006 标准规定的限量要求 Indicates that the concentration of the hazardous substance in the part is above the relevant threshold of the SJ/T 1136 3-2006 standard.</p>						

Description for part 183636-3:

INSERT CAT5E 2x 10/100BT /B

The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hex chrome, mercury, PBB, PBDE, and 0.01% for cadmium, or qualify for an exemption to above limits as defined in the Annex of the EU RoHS Directive. Note that any exemptions taken in this case would not include application specific exemptions (e.g. lead in solder for servers) as TE cannot determine where component products will be used.

Additionally, the part numbers that are identified as 5 of 6 compliant meet the material limits described above, except that these products have lead in the solderable interface only. These products may be suitable for use in an application that has an exemption for the use of lead in solder (e.g. servers, network infrastructure, etc).

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## Statement of Compliance

### Requested Part

05 September 2012

183641-3


( Part 1 of 1)

### INSERT CAT5E 10/100BT & ISDN /B

Status: Active

EU RoHS/ELV Code: 5 of 6 EU RoHS/ELV Compliant

Solder Process Capability Code: Not applicable for solder process capability

China RoHS:  Restricted Materials Above Threshold

Exemptions: 7(x) - Pb-Used for ELV, 5/6 parts

REACH Oct 2008 SvHC Compliance: Not reviewed for REACH October 2008 SvHC(s)

REACH Jan/Mar 2010 SvHC Compliance: Not reviewed for REACH Jan/Mar 2010 SvHC(s)

REACH June 2010 SvHC Compliance: Contains no REACH June 2010 SvHC(s)

REACH Dec 2010 SvHC Compliance: Contains no REACH December 2010 SvHC(s)

REACH June 2011 SvHC Compliance: Not reviewed for REACH June 2011 SvHC(s)

REACH December 2011 SvHC Compliance: Not reviewed for REACH December 2011 SvHC(s)

REACH June 2012 SvHC Compliance: Not reviewed for REACH June 2012 SvHC(s)

Halogen Content: Not Yet Reviewed for halogen content

David R. Bender

Director, Product Compliance

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The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hex chrome, mercury, PBB, PBDE, and 0.01% for cadmium, or qualify for an exemption to above limits as defined in the Annex of the EU RoHS Directive. Note that any exemptions taken in this case would not include application specific exemptions (e.g. lead in solder for servers) as TE cannot determine where component products will be used.

Additionally, the part numbers that are identified as 5 of 6 compliant meet the material limits described above, except that these products have lead in the solderable interface only. These products may be suitable for use in an application that has an exemption for the use of lead in solder (e.g. servers, network infrastructure, etc).

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05 September 2012

中国电子信息产品环境信息  
China EIP Environmental Information



Restricted Materials Above Threshold

电子元件 (Electronic Component) 183641-3	有毒有害物质或元素 Hazardous Substance					
	铅 (Pb)	汞 (Hg)	镉 (Cd)	六价铬 (Cr6)	多溴联苯 (PBB)	多溴二苯醚 (PBDE)
电子元件 (Electronic Component)	X	○	○	○	○	○

O: 表示该部件内有有毒有害物质含量在 SJ/T 11363-2006 标准规定的限量要求以下  
Indicates that the concentration of the hazardous substance in the part is below the relevant threshold of the SJ/T 1136 3-2006 standard.

X: 表示该部件内有有毒有害物质含量超出 SJ/T 11363-2006 标准规定的限量要求  
Indicates that the concentration of the hazardous substance in the part is above the relevant threshold of the SJ/T 1136 3-2006 standard.

Description for part 183641-3:

INSERT CAT5E 10/100BT & ISDN /B

The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hex chrome, mercury, PBB, PBDE, and 0.01% for cadmium, or qualify for an exemption to above limits as defined in the Annex of the EU RoHS Directive. Note that any exemptions taken in this case would not include application specific exemptions (e.g. lead in solder for servers) as TE cannot determine where component products will be used.

Additionally, the part numbers that are identified as 5 of 6 compliant meet the material limits described above, except that these products have lead in the solderable interface only. These products may be suitable for use in an application that has an exemption for the use of lead in solder (e.g. servers, network infrastructure, etc).

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## Statement of Compliance

### Requested Part

05 September 2012

336548-3


( Part 1 of 1)

INSERT CAT6 1x RJ45 T568A /B

Status: Active

EU RoHS/ELV Code: 5 of 6 EU RoHS/ELV Compliant

Solder Process Capability Code: Not applicable for solder process capability

China RoHS:  Restricted Materials Above Threshold

Exemptions: 7(x) - Pb-Used for ELV, 5/6 parts

REACH Oct 2008 SvHC Compliance: Not reviewed for REACH October 2008 SvHC(s)

REACH Jan/Mar 2010 SvHC Compliance: Not reviewed for REACH Jan/Mar 2010 SvHC(s)

REACH June 2010 SvHC Compliance: Contains no REACH June 2010 SvHC(s)

REACH Dec 2010 SvHC Compliance: Contains no REACH December 2010 SvHC(s)

REACH June 2011 SvHC Compliance: Not reviewed for REACH June 2011 SvHC(s)

REACH December 2011 SvHC Compliance: Not reviewed for REACH December 2011 SvHC(s)

REACH June 2012 SvHC Compliance: Not reviewed for REACH June 2012 SvHC(s)

Halogen Content: Not Yet Reviewed for halogen content

David R. Bender

Director, Product Compliance

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The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hex chrome, mercury, PBB, PBDE, and 0.01% for cadmium, or qualify for an exemption to above limits as defined in the Annex of the EU RoHS Directive. Note that any exemptions taken in this case would not include application specific exemptions (e.g. lead in solder for servers) as TE cannot determine where component products will be used.

Additionally, the part numbers that are identified as 5 of 6 compliant meet the material limits described above, except that these products have lead in the solderable interface only. These products may be suitable for use in an application that has an exemption for the use of lead in solder (e.g. servers, network infrastructure, etc).

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05 September 2012

中国电子信息产品环境信息  
China EIP Environmental Information



Restricted Materials Above Threshold

电子元件 (Electronic Component) 336548-3	有毒有害物质或元素 Hazardous Substance					
	铅 (Pb)	汞 (Hg)	镉 (Cd)	六价铬 (Cr6)	多溴联苯 (PBB)	多溴二苯醚 (PBDE)
电子元件 (Electronic Component)	X	O	O	O	O	O
<p>O: 表示该部件内有有毒有害物质含量在 SJ/T 11363-2006 标准规定的限量要求以下 Indicates that the concentration of the hazardous substance in the part is below the relevant threshold of the SJ/T 1136 3-2006 standard.</p> <p>X: 表示该部件内有有毒有害物质含量超出 SJ/T 11363-2006 标准规定的限量要求 Indicates that the concentration of the hazardous substance in the part is above the relevant threshold of the SJ/T 1136 3-2006 standard.</p>						

Description for part 336548-3:

INSERT CAT6 1x RJ45 T568A /B

The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hex chrome, mercury, PBB, PBDE, and 0.01% for cadmium, or qualify for an exemption to above limits as defined in the Annex of the EU RoHS Directive. Note that any exemptions taken in this case would not include application specific exemptions (e.g. lead in solder for servers) as TE cannot determine where component products will be used.

Additionally, the part numbers that are identified as 5 of 6 compliant meet the material limits described above, except that these products have lead in the solderable interface only. These products may be suitable for use in an application that has an exemption for the use of lead in solder (e.g. servers, network infrastructure, etc).

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## Statement of Compliance

### Requested Part

05 September 2012

284584-3

( Part 1 of 1)

INSERT CAT5E 1x RJ45 T568A /B

Status: Active

EU RoHS/ELV Code: 5 of 6 EU RoHS/ELV Compliant

Solder Process Capability Code: Not applicable for solder process capability

China RoHS:  Restricted Materials Above Threshold

Exemptions: 7(x) - Pb-Used for ELV, 5/6 parts

REACH Oct 2008 SvHC Compliance: Not reviewed for REACH October 2008 SvHC(s)

REACH Jan/Mar 2010 SvHC Compliance: Not reviewed for REACH Jan/Mar 2010 SvHC(s)

REACH June 2010 SvHC Compliance: Contains no REACH June 2010 SvHC(s)

REACH Dec 2010 SvHC Compliance: Contains no REACH December 2010 SvHC(s)

REACH June 2011 SvHC Compliance: Not reviewed for REACH June 2011 SvHC(s)

REACH December 2011 SvHC Compliance: Not reviewed for REACH December 2011 SvHC(s)

REACH June 2012 SvHC Compliance: Not reviewed for REACH June 2012 SvHC(s)

Halogen Content: Not Yet Reviewed for halogen content

David R. Bender

Director, Product Compliance

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The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hex chrome, mercury, PBB, PBDE, and 0.01% for cadmium, or qualify for an exemption to above limits as defined in the Annex of the EU RoHS Directive. Note that any exemptions taken in this case would not include application specific exemptions (e.g. lead in solder for servers) as TE cannot determine where component products will be used.

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05 September 2012

中国电子信息产品环境信息  
China EIP Environmental Information



Restricted Materials Above Threshold

电子元件 (Electronic Component) 284584-3	有毒有害物质或元素 Hazardous Substance					
	铅 (Pb)	汞 (Hg)	镉 (Cd)	六价铬 (Cr6)	多溴联苯 (PBB)	多溴二苯醚 (PBDE)
电子元件 (Electronic Component)	X	○	○	○	○	○
<p>○: 表示该部件内有有毒有害物质含量在 SJ/T 11363-2006 标准规定的限量要求以下 Indicates that the concentration of the hazardous substance in the part is below the relevant threshold of the SJ/T 1136 3-2006 standard.</p> <p>X: 表示该部件内有有毒有害物质含量超出 SJ/T 11363-2006 标准规定的限量要求 Indicates that the concentration of the hazardous substance in the part is above the relevant threshold of the SJ/T 1136 3-2006 standard.</p>						

Description for part 284584-3:

INSERT CAT5E 1x RJ45 T568A /B

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## Statement of Compliance

### Requested Part

05 September 2012

183635-5


( Part 1 of 1)

INSERT CAT5E 2x ISDN /W

Status: Active

EU RoHS/ELV Code: 5 of 6 EU RoHS/ELV Compliant

Solder Process Capability Code: Not applicable for solder process capability

China RoHS:  Restricted Materials Above Threshold

Exemptions: 7(x) - Pb-Used for ELV, 5/6 parts

REACH Oct 2008 SvHC Compliance: Not reviewed for REACH October 2008 SvHC(s)

REACH Jan/Mar 2010 SvHC Compliance: Not reviewed for REACH Jan/Mar 2010 SvHC(s)

REACH June 2010 SvHC Compliance: Contains no REACH June 2010 SvHC(s)

REACH Dec 2010 SvHC Compliance: Contains no REACH December 2010 SvHC(s)

REACH June 2011 SvHC Compliance: Not reviewed for REACH June 2011 SvHC(s)

REACH December 2011 SvHC Compliance: Not reviewed for REACH December 2011 SvHC(s)

REACH June 2012 SvHC Compliance: Not reviewed for REACH June 2012 SvHC(s)

Halogen Content: Not Yet Reviewed for halogen content

David R. Bender

Director, Product Compliance

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05 September 2012

中国电子信息产品环境信息  
China EIP Environmental Information



Restricted Materials Above Threshold

电子元件 (Electronic Component) 183635-5	有毒有害物质或元素 Hazardous Substance					
	铅 (Pb)	汞 (Hg)	镉 (Cd)	六价铬 (Cr6)	多溴联苯 (PBB)	多溴二苯醚 (PBDE)
电子元件 (Electronic Component)	X	○	○	○	○	○
<p>○: 表示该部件内有有毒有害物质含量在 SJ/T 11363-2006 标准规定的限量要求以下 Indicates that the concentration of the hazardous substance in the part is below the relevant threshold of the SJ/T 1136 3-2006 standard.</p> <p>X: 表示该部件内有有毒有害物质含量超出 SJ/T 11363-2006 标准规定的限量要求 Indicates that the concentration of the hazardous substance in the part is above the relevant threshold of the SJ/T 1136 3-2006 standard.</p>						

Description for part 183635-5:

INSERT CAT5E 2x ISDN /W

The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hex chrome, mercury, PBB, PBDE, and 0.01% for cadmium, or qualify for an exemption to above limits as defined in the Annex of the EU RoHS Directive. Note that any exemptions taken in this case would not include application specific exemptions (e.g. lead in solder for servers) as TE cannot determine where component products will be used.

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## Statement of Compliance

### Requested Part

05 September 2012

183636-5

( Part 1 of 1)

INSERT CAT5E 2x 10/100BT /W

Status: Active

EU RoHS/ELV Code: 5 of 6 EU RoHS/ELV Compliant

Solder Process Capability Code: Not applicable for solder process capability

China RoHS:  Restricted Materials Above Threshold

Exemptions: 7(x) - Pb-Used for ELV, 5/6 parts

REACH Oct 2008 SvHC Compliance: Not reviewed for REACH October 2008 SvHC(s)

REACH Jan/Mar 2010 SvHC Compliance: Not reviewed for REACH Jan/Mar 2010 SvHC(s)

REACH June 2010 SvHC Compliance: Contains no REACH June 2010 SvHC(s)

REACH Dec 2010 SvHC Compliance: Contains no REACH December 2010 SvHC(s)

REACH June 2011 SvHC Compliance: Not reviewed for REACH June 2011 SvHC(s)

REACH December 2011 SvHC Compliance: Not reviewed for REACH December 2011 SvHC(s)

REACH June 2012 SvHC Compliance: Not reviewed for REACH June 2012 SvHC(s)

Halogen Content: Not Yet Reviewed for halogen content

David R. Bender

Director, Product Compliance

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The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hex chrome, mercury, PBB, PBDE, and 0.01% for cadmium, or qualify for an exemption to above limits as defined in the Annex of the EU RoHS Directive. Note that any exemptions taken in this case would not include application specific exemptions (e.g. lead in solder for servers) as TE cannot determine where component products will be used.

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中国电子信息产品环境信息  
China EIP Environmental Information



Restricted Materials Above Threshold

电子元件 (Electronic Component) 183636-5	有毒有害物质或元素 Hazardous Substance					
	铅 (Pb)	汞 (Hg)	镉 (Cd)	六价铬 (Cr6)	多溴联苯 (PBB)	多溴二苯醚 (PBDE)
电子元件 (Electronic Component)	X	O	O	O	O	O

O: 表示该部件内有有毒有害物质含量在 SJ/T 11363-2006 标准规定的限量要求以下  
Indicates that the concentration of the hazardous substance in the part is below the relevant threshold of the SJ/T 1136 3-2006 standard.

X: 表示该部件内有有毒有害物质含量超出 SJ/T 11363-2006 标准规定的限量要求  
Indicates that the concentration of the hazardous substance in the part is above the relevant threshold of the SJ/T 1136 3-2006 standard.

Description for part 183636-5:

INSERT CAT5E 2x 10/100BT /W

The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hex chrome, mercury, PBB, PBDE, and 0.01% for cadmium, or qualify for an exemption to above limits as defined in the Annex of the EU RoHS Directive. Note that any exemptions taken in this case would not include application specific exemptions (e.g. lead in solder for servers) as TE cannot determine where component products will be used.

Additionally, the part numbers that are identified as 5 of 6 compliant meet the material limits described above, except that these products have lead in the solderable interface only. These products may be suitable for use in an application that has an exemption for the use of lead in solder (e.g. servers, network infrastructure, etc).

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information provided by our suppliers. This information is subject to change.





## Statement of Compliance

### Requested Part

05 September 2012

183641-5


( Part 1 of 1)

### INSERT CAT5E 10/100BT & ISDN /W

Status: Active

EU RoHS/ELV Code: 5 of 6 EU RoHS/ELV Compliant

Solder Process Capability Code: Not applicable for solder process capability

China RoHS:  Restricted Materials Above Threshold

Exemptions: 7(x) - Pb-Used for ELV, 5/6 parts

REACH Oct 2008 SvHC Compliance: Not reviewed for REACH October 2008 SvHC(s)

REACH Jan/Mar 2010 SvHC Compliance: Not reviewed for REACH Jan/Mar 2010 SvHC(s)

REACH June 2010 SvHC Compliance: Contains no REACH June 2010 SvHC(s)

REACH Dec 2010 SvHC Compliance: Contains no REACH December 2010 SvHC(s)

REACH June 2011 SvHC Compliance: Not reviewed for REACH June 2011 SvHC(s)

REACH December 2011 SvHC Compliance: Not reviewed for REACH December 2011 SvHC(s)

REACH June 2012 SvHC Compliance: Not reviewed for REACH June 2012 SvHC(s)

Halogen Content: Not Yet Reviewed for halogen content

David R. Bender

Director, Product Compliance

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The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hex chrome, mercury, PBB, PBDE, and 0.01% for cadmium, or qualify for an exemption to above limits as defined in the Annex of the EU RoHS Directive. Note that any exemptions taken in this case would not include application specific exemptions (e.g. lead in solder for servers) as TE cannot determine where component products will be used.

Additionally, the part numbers that are identified as 5 of 6 compliant meet the material limits described above, except that these products have lead in the solderable interface only. These products may be suitable for use in an application that has an exemption for the use of lead in solder (e.g. servers, network infrastructure, etc).

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information provided by our suppliers. This information is subject to change.



05 September 2012

中国电子信息产品环境信息  
China EIP Environmental Information



Restricted Materials Above Threshold

电子元件 (Electronic Component) 183641-5	有毒有害物质或元素 Hazardous Substance					
	铅 (Pb)	汞 (Hg)	镉 (Cd)	六价铬 (Cr6)	多溴联苯 (PBB)	多溴二苯醚 (PBDE)
电子元件 (Electronic Component)	X	O	O	O	O	O

O: 表示该部件内有有毒有害物质含量在 SJ/T 11363-2006 标准规定的限量要求以下  
Indicates that the concentration of the hazardous substance in the part is below the relevant threshold of the SJ/T 1136 3-2006 standard.

X: 表示该部件内有有毒有害物质含量超出 SJ/T 11363-2006 标准规定的限量要求  
Indicates that the concentration of the hazardous substance in the part is above the relevant threshold of the SJ/T 1136 3-2006 standard.

Description for part 183641-5:

INSERT CAT5E 10/100BT & ISDN /W

The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hex chrome, mercury, PBB, PBDE, and 0.01% for cadmium, or qualify for an exemption to above limits as defined in the Annex of the EU RoHS Directive. Note that any exemptions taken in this case would not include application specific exemptions (e.g. lead in solder for servers) as TE cannot determine where component products will be used.

Additionally, the part numbers that are identified as 5 of 6 compliant meet the material limits described above, except that these products have lead in the solderable interface only. These products may be suitable for use in an application that has an exemption for the use of lead in solder (e.g. servers, network infrastructure, etc).

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information provided by our suppliers. This information is subject to change.



## Statement of Compliance

### Requested Part

05 September 2012

336480-5

( Part 1 of 1)

### ASSY ISO CAT 7 AMP CO INSERT W

Status: Superseded

EU RoHS/ELV Code: 5 of 6 EU RoHS/ELV Compliant

Solder Process Capability Code: Not applicable for solder process capability

China RoHS: Not reviewed for China RoHS compliance

Exemptions: Exemption Details Currently Unavailable

REACH Oct 2008 SvHC Compliance: Not reviewed for REACH October 2008 SvHC(s)

REACH Jan/Mar 2010 SvHC Compliance: Not reviewed for REACH Jan/Mar 2010 SvHC(s)

REACH June 2010 SvHC Compliance: Not reviewed for REACH June 2010 SvHC(s)

REACH Dec 2010 SvHC Compliance: Not reviewed for REACH December 2010 SvHC(s)

REACH June 2011 SvHC Compliance: Not reviewed for REACH June 2011 SvHC(s)

REACH December 2011 SvHC Compliance: Not reviewed for REACH December 2011 SvHC(s)

REACH June 2012 SvHC Compliance: Not reviewed for REACH June 2012 SvHC(s)

Halogen Content: Not Yet Reviewed for halogen content

David R. Bender

Director, Product Compliance

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The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hex chrome, mercury, PBB, PBDE, and 0.01% for cadmium, or qualify for an exemption to above limits as defined in the Annex of the EU RoHS Directive. Note that any exemptions taken in this case would not include application specific exemptions (e.g. lead in solder for servers) as TE cannot determine where component products will be used.

Additionally, the part numbers that are identified as 5 of 6 compliant meet the material limits described above, except that these products have lead in the solderable interface only. These products may be suitable for use in an application that has an exemption for the use of lead in solder (e.g. servers, network infrastructure, etc).

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information provided by our suppliers. This information is subject to change.



RoHS Equivalent Part(s) for Part 336480-5

05 September 2012

1711409-5


(Equivalent Part 1 of 1)

INSERT CAT7a AMPTWIST7aS style /W

Status: Active

EU RoHS/ELV Code: 5 of 6 EU RoHS/ELV Compliant

Solder Process Capability Code: Not applicable for solder process capability

China RoHS:  Restricted Materials Above Threshold

Exemptions: 6(c) - Pb-Alloy in Copper

7(x) - Pb-Used for ELV, 5/6 parts

REACH Oct 2008 SvHC Compliance: Not reviewed for REACH October 2008 SvHC(s)

REACH Jan/Mar 2010 SvHC Compliance: Not reviewed for REACH Jan/Mar 2010 SvHC(s)

REACH June 2010 SvHC Compliance: Contains no REACH June 2010 SvHC(s)

REACH Dec 2010 SvHC Compliance: Contains no REACH December 2010 SvHC(s)

REACH June 2011 SvHC Compliance: Not reviewed for REACH June 2011 SvHC(s)

REACH December 2011 SvHC Compliance: Not reviewed for REACH December 2011 SvHC(s)

REACH June 2012 SvHC Compliance: Not reviewed for REACH June 2012 SvHC(s)

Halogen Content: Not Yet Reviewed for halogen content

Description of Difference: New wiring

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The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hex chrome, mercury, PBB, PBDE, and 0.01% for cadmium, or qualify for an exemption to above limits as defined in the Annex of the EU RoHS Directive. Note that any exemptions taken in this case would not include application specific exemptions (e.g. lead in solder for servers) as TE cannot determine where component products will be used.

Additionally, the part numbers that are identified as 5 of 6 compliant meet the material limits described above, except that these products have lead in the solderable interface only. These products may be suitable for use in an application that has an exemption for the use of lead in solder (e.g. servers, network infrastructure, etc).

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## Statement of Compliance

### Requested Part

05 September 2012

336548-5


( Part 1 of 1)

INSERT CAT6 1x RJ45 T568A /W

Status: Active

EU RoHS/ELV Code: 5 of 6 EU RoHS/ELV Compliant

Solder Process Capability Code: Not applicable for solder process capability

China RoHS:  Restricted Materials Above Threshold

Exemptions: 7(x) - Pb-Used for ELV, 5/6 parts

REACH Oct 2008 SvHC Compliance: Not reviewed for REACH October 2008 SvHC(s)

REACH Jan/Mar 2010 SvHC Compliance: Not reviewed for REACH Jan/Mar 2010 SvHC(s)

REACH June 2010 SvHC Compliance: Contains no REACH June 2010 SvHC(s)

REACH Dec 2010 SvHC Compliance: Contains no REACH December 2010 SvHC(s)

REACH June 2011 SvHC Compliance: Not reviewed for REACH June 2011 SvHC(s)

REACH December 2011 SvHC Compliance: Not reviewed for REACH December 2011 SvHC(s)

REACH June 2012 SvHC Compliance: Not reviewed for REACH June 2012 SvHC(s)

Halogen Content: Not Yet Reviewed for halogen content

David R. Bender

Director, Product Compliance

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The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hex chrome, mercury, PBB, PBDE, and 0.01% for cadmium, or qualify for an exemption to above limits as defined in the Annex of the EU RoHS Directive. Note that any exemptions taken in this case would not include application specific exemptions (e.g. lead in solder for servers) as TE cannot determine where component products will be used.

Additionally, the part numbers that are identified as 5 of 6 compliant meet the material limits described above, except that these products have lead in the solderable interface only. These products may be suitable for use in an application that has an exemption for the use of lead in solder (e.g. servers, network infrastructure, etc).

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information provided by our suppliers. This information is subject to change.



05 September 2012

中国电子信息产品环境信息  
China EIP Environmental Information



Restricted Materials Above Threshold

电子元件 (Electronic Component) 336548-5	有毒有害物质或元素 Hazardous Substance					
	铅 (Pb)	汞 (Hg)	镉 (Cd)	六价铬 (Cr6)	多溴联苯 (PBB)	多溴二苯醚 (PBDE)
电子元件 (Electronic Component)	X	O	O	O	O	O
<p>O: 表示该部件内有有毒有害物质含量在 SJ/T 11363-2006 标准规定的限量要求以下 Indicates that the concentration of the hazardous substance in the part is below the relevant threshold of the SJ/T 1136 3-2006 standard.</p> <p>X: 表示该部件内有有毒有害物质含量超出 SJ/T 11363-2006 标准规定的限量要求 Indicates that the concentration of the hazardous substance in the part is above the relevant threshold of the SJ/T 1136 3-2006 standard.</p>						

Description for part 336548-5:

INSERT CAT6 1x RJ45 T568A /W

The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hex chrome, mercury, PBB, PBDE, and 0.01% for cadmium, or qualify for an exemption to above limits as defined in the Annex of the EU RoHS Directive. Note that any exemptions taken in this case would not include application specific exemptions (e.g. lead in solder for servers) as TE cannot determine where component products will be used.

Additionally, the part numbers that are identified as 5 of 6 compliant meet the material limits described above, except that these products have lead in the solderable interface only. These products may be suitable for use in an application that has an exemption for the use of lead in solder (e.g. servers, network infrastructure, etc).

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## Statement of Compliance

### Requested Part

05 September 2012

284584-5


( Part 1 of 1)

INSERT CAT5E 1x RJ45 T568A /W

Status: Active

EU RoHS/ELV Code: 5 of 6 EU RoHS/ELV Compliant

Solder Process Capability Code: Not applicable for solder process capability

China RoHS:  Restricted Materials Above Threshold

Exemptions: 7(x) - Pb-Used for ELV, 5/6 parts

REACH Oct 2008 SvHC Compliance: Not reviewed for REACH October 2008 SvHC(s)

REACH Jan/Mar 2010 SvHC Compliance: Not reviewed for REACH Jan/Mar 2010 SvHC(s)

REACH June 2010 SvHC Compliance: Contains no REACH June 2010 SvHC(s)

REACH Dec 2010 SvHC Compliance: Contains no REACH December 2010 SvHC(s)

REACH June 2011 SvHC Compliance: Not reviewed for REACH June 2011 SvHC(s)

REACH December 2011 SvHC Compliance: Not reviewed for REACH December 2011 SvHC(s)

REACH June 2012 SvHC Compliance: Not reviewed for REACH June 2012 SvHC(s)

Halogen Content: Not Yet Reviewed for halogen content

David R. Bender

Director, Product Compliance

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The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hex chrome, mercury, PBB, PBDE, and 0.01% for cadmium, or qualify for an exemption to above limits as defined in the Annex of the EU RoHS Directive. Note that any exemptions taken in this case would not include application specific exemptions (e.g. lead in solder for servers) as TE cannot determine where component products will be used.

Additionally, the part numbers that are identified as 5 of 6 compliant meet the material limits described above, except that these products have lead in the solderable interface only. These products may be suitable for use in an application that has an exemption for the use of lead in solder (e.g. servers, network infrastructure, etc).

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information provided by our suppliers. This information is subject to change.



05 September 2012

中国电子信息产品环境信息  
China EIP Environmental Information



Restricted Materials Above Threshold

电子元件 (Electronic Component) 284584-5	有毒有害物质或元素 Hazardous Substance					
	铅 (Pb)	汞 (Hg)	镉 (Cd)	六价铬 (Cr6)	多溴联苯 (PBB)	多溴二苯醚 (PBDE)
电子元件 (Electronic Component)	X	○	○	○	○	○
<p>○: 表示该部件内有有毒有害物质含量在 SJ/T 11363-2006 标准规定的限量要求以下 Indicates that the concentration of the hazardous substance in the part is below the relevant threshold of the SJ/T 1136 3-2006 standard.</p> <p>X: 表示该部件内有有毒有害物质含量超出 SJ/T 11363-2006 标准规定的限量要求 Indicates that the concentration of the hazardous substance in the part is above the relevant threshold of the SJ/T 1136 3-2006 standard.</p>						

Description for part 284584-5:

INSERT CAT5E 1x RJ45 T568A /W

The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hex chrome, mercury, PBB, PBDE, and 0.01% for cadmium, or qualify for an exemption to above limits as defined in the Annex of the EU RoHS Directive. Note that any exemptions taken in this case would not include application specific exemptions (e.g. lead in solder for servers) as TE cannot determine where component products will be used.

Additionally, the part numbers that are identified as 5 of 6 compliant meet the material limits described above, except that these products have lead in the solderable interface only. These products may be suitable for use in an application that has an exemption for the use of lead in solder (e.g. servers, network infrastructure, etc).

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## Statement of Compliance

### Requested Part

05 September 2012

336554-5


( Part 1 of 1)

INSERT CAT6 2x ISDN /W

Status: Superseded

EU RoHS/ELV Code: 5 of 6 EU RoHS/ELV Compliant

Solder Process Capability Code: Not applicable for solder process capability

China RoHS:  Restricted Materials Above Threshold

Exemptions: 7(x) - Pb-Used for ELV, 5/6 parts

REACH Oct 2008 SvHC Compliance: Not reviewed for REACH October 2008 SvHC(s)

REACH Jan/Mar 2010 SvHC Compliance: Not reviewed for REACH Jan/Mar 2010 SvHC(s)

REACH June 2010 SvHC Compliance: Contains no REACH June 2010 SvHC(s)

REACH Dec 2010 SvHC Compliance: Contains no REACH December 2010 SvHC(s)

REACH June 2011 SvHC Compliance: Not reviewed for REACH June 2011 SvHC(s)

REACH December 2011 SvHC Compliance: Not reviewed for REACH December 2011 SvHC(s)

REACH June 2012 SvHC Compliance: Not reviewed for REACH June 2012 SvHC(s)

Halogen Content: Not Yet Reviewed for halogen content

David R. Bender

Director, Product Compliance

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The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hex chrome, mercury, PBB, PBDE, and 0.01% for cadmium, or qualify for an exemption to above limits as defined in the Annex of the EU RoHS Directive. Note that any exemptions taken in this case would not include application specific exemptions (e.g. lead in solder for servers) as TE cannot determine where component products will be used.

Additionally, the part numbers that are identified as 5 of 6 compliant meet the material limits described above, except that these products have lead in the solderable interface only. These products may be suitable for use in an application that has an exemption for the use of lead in solder (e.g. servers, network infrastructure, etc).

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RoHS Equivalent Part(s) for Part 336554-5

05 September 2012

1711807-5

(Equivalent Part 1 of 1)

INSERT CAT6a 2x ISDN /W

Status: Active

EU RoHS/ELV Code: Always EU RoHS/ELV Compliant

Solder Process Capability Code: Not applicable for solder process capability

China RoHS:  No Restricted Materials Above Threshold

Exemptions: No Substance>Threshold

REACH Oct 2008 SvHC Compliance: Not reviewed for REACH October 2008 SvHC(s)

REACH Jan/Mar 2010 SvHC Compliance: Not reviewed for REACH Jan/Mar 2010 SvHC(s)

REACH June 2010 SvHC Compliance: Contains no REACH June 2010 SvHC(s)

REACH Dec 2010 SvHC Compliance: Contains no REACH December 2010 SvHC(s)

REACH June 2011 SvHC Compliance: Not reviewed for REACH June 2011 SvHC(s)

REACH December 2011 SvHC Compliance: Not reviewed for REACH December 2011 SvHC(s)

REACH June 2012 SvHC Compliance: Not reviewed for REACH June 2012 SvHC(s)

Halogen Content: Not Yet Reviewed for halogen content

Description of Difference: New Cat6A Inserts

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The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hex chrome, mercury, PBB, PBDE, and 0.01% for cadmium, or qualify for an exemption to above limits as defined in the Annex of the EU RoHS Directive. Note that any exemptions taken in this case would not include application specific exemptions (e.g. lead in solder for servers) as TE cannot determine where component products will be used.

Additionally, the part numbers that are identified as 5 of 6 compliant meet the material limits described above, except that these products have lead in the solderable interface only. These products may be suitable for use in an application that has an exemption for the use of lead in solder (e.g. servers, network infrastructure, etc).

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05 September 2012

中国电子信息产品环境信息  
China EIP Environmental Information



Restricted Materials Above Threshold

电子元件 (Electronic Component) 336554-5	有毒有害物质或元素 Hazardous Substance					
	铅 (Pb)	汞 (Hg)	镉 (Cd)	六价铬 (Cr6)	多溴联苯 (PBB)	多溴二苯醚 (PBDE)
电子元件 (Electronic Component)	X	○	○	○	○	○
<p>O: 表示该部件内有有毒有害物质含量在 SJ/T 11363-2006 标准规定的限量要求以下 Indicates that the concentration of the hazardous substance in the part is below the relevant threshold of the SJ/T 1136 3-2006 standard.</p> <p>X: 表示该部件内有有毒有害物质含量超出 SJ/T 11363-2006 标准规定的限量要求 Indicates that the concentration of the hazardous substance in the part is above the relevant threshold of the SJ/T 1136 3-2006 standard.</p>						

Description for part 336554-5:

INSERT CAT6 2x ISDN /W

The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hex chrome, mercury, PBB, PBDE, and 0.01% for cadmium, or qualify for an exemption to above limits as defined in the Annex of the EU RoHS Directive. Note that any exemptions taken in this case would not include application specific exemptions (e.g. lead in solder for servers) as TE cannot determine where component products will be used.

Additionally, the part numbers that are identified as 5 of 6 compliant meet the material limits described above, except that these products have lead in the solderable interface only. These products may be suitable for use in an application that has an exemption for the use of lead in solder (e.g. servers, network infrastructure, etc).

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information provided by our suppliers. This information is subject to change.



## Statement of Compliance

### Requested Part

05 September 2012

336553-5

( Part 1 of 1)

INSERT CAT6 2x 10/100BT /W

Status: Superseded

EU RoHS/ELV Code: 5 of 6 EU RoHS/ELV Compliant

Solder Process Capability Code: Not applicable for solder process capability

China RoHS:  Restricted Materials Above Threshold

Exemptions: 7(x) - Pb-Used for ELV, 5/6 parts

REACH Oct 2008 SvHC Compliance: Not reviewed for REACH October 2008 SvHC(s)

REACH Jan/Mar 2010 SvHC Compliance: Not reviewed for REACH Jan/Mar 2010 SvHC(s)

REACH June 2010 SvHC Compliance: Contains no REACH June 2010 SvHC(s)

REACH Dec 2010 SvHC Compliance: Contains no REACH December 2010 SvHC(s)

REACH June 2011 SvHC Compliance: Not reviewed for REACH June 2011 SvHC(s)

REACH December 2011 SvHC Compliance: Not reviewed for REACH December 2011 SvHC(s)

REACH June 2012 SvHC Compliance: Not reviewed for REACH June 2012 SvHC(s)

Halogen Content: Not Yet Reviewed for halogen content

David R. Bender

Director, Product Compliance

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The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hex chrome, mercury, PBB, PBDE, and 0.01% for cadmium, or qualify for an exemption to above limits as defined in the Annex of the EU RoHS Directive. Note that any exemptions taken in this case would not include application specific exemptions (e.g. lead in solder for servers) as TE cannot determine where component products will be used.

Additionally, the part numbers that are identified as 5 of 6 compliant meet the material limits described above, except that these products have lead in the solderable interface only. These products may be suitable for use in an application that has an exemption for the use of lead in solder (e.g. servers, network infrastructure, etc).

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**RoHS Equivalent Part(s) for Part 336553-5**

05 September 2012

1711801-5

(Equivalent Part 1 of 1)

INSERT CAT6a 2x 10/100BT /W

Status: Active

EU RoHS/ELV Code: Always EU RoHS/ELV Compliant

Solder Process Capability Code: Not applicable for solder process capability

China RoHS:  No Restricted Materials Above Threshold

Exemptions: No Substance>Threshold

REACH Oct 2008 SvHC Compliance: Not reviewed for REACH October 2008 SvHC(s)

REACH Jan/Mar 2010 SvHC Compliance: Not reviewed for REACH Jan/Mar 2010 SvHC(s)

REACH June 2010 SvHC Compliance: Contains no REACH June 2010 SvHC(s)

REACH Dec 2010 SvHC Compliance: Contains no REACH December 2010 SvHC(s)

REACH June 2011 SvHC Compliance: Not reviewed for REACH June 2011 SvHC(s)

REACH December 2011 SvHC Compliance: Not reviewed for REACH December 2011 SvHC(s)

REACH June 2012 SvHC Compliance: Not reviewed for REACH June 2012 SvHC(s)

Halogen Content: Not Yet Reviewed for halogen content

Description of Difference: New Cat6A Inserts

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The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hex chrome, mercury, PBB, PBDE, and 0.01% for cadmium, or qualify for an exemption to above limits as defined in the Annex of the EU RoHS Directive. Note that any exemptions taken in this case would not include application specific exemptions (e.g. lead in solder for servers) as TE cannot determine where component products will be used.

Additionally, the part numbers that are identified as 5 of 6 compliant meet the material limits described above, except that these products have lead in the solderable interface only. These products may be suitable for use in an application that has an exemption for the use of lead in solder (e.g. servers, network infrastructure, etc).

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05 September 2012

中国电子信息产品环境信息  
China EIP Environmental Information



Restricted Materials Above Threshold

电子元件 (Electronic Component) 336553-5	有毒有害物质或元素 Hazardous Substance					
	铅 (Pb)	汞 (Hg)	镉 (Cd)	六价铬 (Cr6)	多溴联苯 (PBB)	多溴二苯醚 (PBDE)
电子元件 (Electronic Component)	X	O	O	O	O	O

O: 表示该部件内有有毒有害物质含量在 SJ/T 11363-2006 标准规定的限量要求以下  
Indicates that the concentration of the hazardous substance in the part is below the relevant threshold of the SJ/T 1136 3-2006 standard.

X: 表示该部件内有有毒有害物质含量超出 SJ/T 11363-2006 标准规定的限量要求  
Indicates that the concentration of the hazardous substance in the part is above the relevant threshold of the SJ/T 1136 3-2006 standard.

Description for part 336553-5:

INSERT CAT6 2x 10/100BT /W

The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hex chrome, mercury, PBB, PBDE, and 0.01% for cadmium, or qualify for an exemption to above limits as defined in the Annex of the EU RoHS Directive. Note that any exemptions taken in this case would not include application specific exemptions (e.g. lead in solder for servers) as TE cannot determine where component products will be used.

Additionally, the part numbers that are identified as 5 of 6 compliant meet the material limits described above, except that these products have lead in the solderable interface only. These products may be suitable for use in an application that has an exemption for the use of lead in solder (e.g. servers, network infrastructure, etc).

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information provided by our suppliers. This information is subject to change.



## Statement of Compliance

### Requested Part

05 September 2012

336549-5

( Part 1 of 1)

### INSERT CAT6 10/100BT & ISDN /W

Status: Superseded

EU RoHS/ELV Code: 5 of 6 EU RoHS/ELV Compliant

Solder Process Capability Code: Not applicable for solder process capability

China RoHS:  Restricted Materials Above Threshold

Exemptions: 7(x) - Pb-Used for ELV, 5/6 parts

REACH Oct 2008 SvHC Compliance: Not reviewed for REACH October 2008 SvHC(s)

REACH Jan/Mar 2010 SvHC Compliance: Not reviewed for REACH Jan/Mar 2010 SvHC(s)

REACH June 2010 SvHC Compliance: Contains no REACH June 2010 SvHC(s)

REACH Dec 2010 SvHC Compliance: Contains no REACH December 2010 SvHC(s)

REACH June 2011 SvHC Compliance: Not reviewed for REACH June 2011 SvHC(s)

REACH December 2011 SvHC Compliance: Not reviewed for REACH December 2011 SvHC(s)

REACH June 2012 SvHC Compliance: Not reviewed for REACH June 2012 SvHC(s)

Halogen Content: Not Yet Reviewed for halogen content

David R. Bender

Director, Product Compliance

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The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hex chrome, mercury, PBB, PBDE, and 0.01% for cadmium, or qualify for an exemption to above limits as defined in the Annex of the EU RoHS Directive. Note that any exemptions taken in this case would not include application specific exemptions (e.g. lead in solder for servers) as TE cannot determine where component products will be used.

Additionally, the part numbers that are identified as 5 of 6 compliant meet the material limits described above, except that these products have lead in the solderable interface only. These products may be suitable for use in an application that has an exemption for the use of lead in solder (e.g. servers, network infrastructure, etc).

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**RoHS Equivalent Part(s) for Part 336549-5**

05 September 2012

**1711804-5**

(Equivalent Part 1 of 1)

INSERT CAT6a 10/100BT & ISDN /W

Status: Active

EU RoHS/ELV Code: Always EU RoHS/ELV Compliant

Solder Process Capability Code: Not applicable for solder process capability

China RoHS:  No Restricted Materials Above Threshold

Exemptions: No Substance>Threshold

REACH Oct 2008 SvHC Compliance: Not reviewed for REACH October 2008 SvHC(s)

REACH Jan/Mar 2010 SvHC Compliance: Not reviewed for REACH Jan/Mar 2010 SvHC(s)

REACH June 2010 SvHC Compliance: Contains no REACH June 2010 SvHC(s)

REACH Dec 2010 SvHC Compliance: Contains no REACH December 2010 SvHC(s)

REACH June 2011 SvHC Compliance: Not reviewed for REACH June 2011 SvHC(s)

REACH December 2011 SvHC Compliance: Not reviewed for REACH December 2011 SvHC(s)

REACH June 2012 SvHC Compliance: Not reviewed for REACH June 2012 SvHC(s)

Halogen Content: Not Yet Reviewed for halogen content

Description of Difference: New Cat6A Inserts

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The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hex chrome, mercury, PBB, PBDE, and 0.01% for cadmium, or qualify for an exemption to above limits as defined in the Annex of the EU RoHS Directive. Note that any exemptions taken in this case would not include application specific exemptions (e.g. lead in solder for servers) as TE cannot determine where component products will be used.

Additionally, the part numbers that are identified as 5 of 6 compliant meet the material limits described above, except that these products have lead in the solderable interface only. These products may be suitable for use in an application that has an exemption for the use of lead in solder (e.g. servers, network infrastructure, etc).

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05 September 2012

中国电子信息产品环境信息  
China EIP Environmental Information



Restricted Materials Above Threshold

电子元件 (Electronic Component) 336549-5	有毒有害物质或元素 Hazardous Substance					
	铅 (Pb)	汞 (Hg)	镉 (Cd)	六价铬 (Cr6)	多溴联苯 (PBB)	多溴二苯醚 (PBDE)
电子元件 (Electronic Component)	X	O	O	O	O	O
<p>O: 表示该部件内有有毒有害物质含量在 SJ/T 11363-2006 标准规定的限量要求以下 Indicates that the concentration of the hazardous substance in the part is below the relevant threshold of the SJ/T 1136 3-2006 standard.</p> <p>X: 表示该部件内有有毒有害物质含量超出 SJ/T 11363-2006 标准规定的限量要求 Indicates that the concentration of the hazardous substance in the part is above the relevant threshold of the SJ/T 1136 3-2006 standard.</p>						

Description for part 336549-5:

INSERT CAT6 10/100BT & ISDN /W

The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hex chrome, mercury, PBB, PBDE, and 0.01% for cadmium, or qualify for an exemption to above limits as defined in the Annex of the EU RoHS Directive. Note that any exemptions taken in this case would not include application specific exemptions (e.g. lead in solder for servers) as TE cannot determine where component products will be used.

Additionally, the part numbers that are identified as 5 of 6 compliant meet the material limits described above, except that these products have lead in the solderable interface only. These products may be suitable for use in an application that has an exemption for the use of lead in solder (e.g. servers, network infrastructure, etc).

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information provided by our suppliers. This information is subject to change.



## Statement of Compliance

### Requested Part

05 September 2012

183635-1

( Part 1 of 1)

INSERT CAT5E 2x ISDN /A

Status: Active

EU RoHS/ELV Code: 5 of 6 EU RoHS/ELV Compliant

Solder Process Capability Code: Not applicable for solder process capability

China RoHS:  Restricted Materials Above Threshold

Exemptions: 7(x) - Pb-Used for ELV, 5/6 parts

REACH Oct 2008 SvHC Compliance: Not reviewed for REACH October 2008 SvHC(s)

REACH Jan/Mar 2010 SvHC Compliance: Not reviewed for REACH Jan/Mar 2010 SvHC(s)

REACH June 2010 SvHC Compliance: Contains no REACH June 2010 SvHC(s)

REACH Dec 2010 SvHC Compliance: Contains no REACH December 2010 SvHC(s)

REACH June 2011 SvHC Compliance: Not reviewed for REACH June 2011 SvHC(s)

REACH December 2011 SvHC Compliance: Not reviewed for REACH December 2011 SvHC(s)

REACH June 2012 SvHC Compliance: Not reviewed for REACH June 2012 SvHC(s)

Halogen Content: Not Yet Reviewed for halogen content

David R. Bender

Director, Product Compliance

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The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hex chrome, mercury, PBB, PBDE, and 0.01% for cadmium, or qualify for an exemption to above limits as defined in the Annex of the EU RoHS Directive. Note that any exemptions taken in this case would not include application specific exemptions (e.g. lead in solder for servers) as TE cannot determine where component products will be used.

Additionally, the part numbers that are identified as 5 of 6 compliant meet the material limits described above, except that these products have lead in the solderable interface only. These products may be suitable for use in an application that has an exemption for the use of lead in solder (e.g. servers, network infrastructure, etc).

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information provided by our suppliers. This information is subject to change.



05 September 2012

中国电子信息产品环境信息  
China EIP Environmental Information



Restricted Materials Above Threshold

电子元件 (Electronic Component) 183635-1	有毒有害物质或元素 Hazardous Substance					
	铅 (Pb)	汞 (Hg)	镉 (Cd)	六价铬 (Cr6)	多溴联苯 (PBB)	多溴二苯醚 (PBDE)
电子元件 (Electronic Component)	X	O	O	O	O	O
<p>O: 表示该部件内有有毒有害物质含量在 SJ/T 11363-2006 标准规定的限量要求以下 Indicates that the concentration of the hazardous substance in the part is below the relevant threshold of the SJ/T 1136 3-2006 standard.</p> <p>X: 表示该部件内有有毒有害物质含量超出 SJ/T 11363-2006 标准规定的限量要求 Indicates that the concentration of the hazardous substance in the part is above the relevant threshold of the SJ/T 1136 3-2006 standard.</p>						

Description for part 183635-1:

INSERT CAT5E 2x ISDN /A

The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hex chrome, mercury, PBB, PBDE, and 0.01% for cadmium, or qualify for an exemption to above limits as defined in the Annex of the EU RoHS Directive. Note that any exemptions taken in this case would not include application specific exemptions (e.g. lead in solder for servers) as TE cannot determine where component products will be used.

Additionally, the part numbers that are identified as 5 of 6 compliant meet the material limits described above, except that these products have lead in the solderable interface only. These products may be suitable for use in an application that has an exemption for the use of lead in solder (e.g. servers, network infrastructure, etc).

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information provided by our suppliers. This information is subject to change.



## Statement of Compliance

### Requested Part

05 September 2012

183636-1


( Part 1 of 1)

INSERT CAT5E 2x 10/100BT /A

Status: Active

EU RoHS/ELV Code: 5 of 6 EU RoHS/ELV Compliant

Solder Process Capability Code: Not applicable for solder process capability

China RoHS:  Restricted Materials Above Threshold

Exemptions: 7(x) - Pb-Used for ELV, 5/6 parts

REACH Oct 2008 SvHC Compliance: Not reviewed for REACH October 2008 SvHC(s)

REACH Jan/Mar 2010 SvHC Compliance: Not reviewed for REACH Jan/Mar 2010 SvHC(s)

REACH June 2010 SvHC Compliance: Contains no REACH June 2010 SvHC(s)

REACH Dec 2010 SvHC Compliance: Contains no REACH December 2010 SvHC(s)

REACH June 2011 SvHC Compliance: Not reviewed for REACH June 2011 SvHC(s)

REACH December 2011 SvHC Compliance: Not reviewed for REACH December 2011 SvHC(s)

REACH June 2012 SvHC Compliance: Not reviewed for REACH June 2012 SvHC(s)

Halogen Content: Not Yet Reviewed for halogen content

David R. Bender

Director, Product Compliance

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The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hex chrome, mercury, PBB, PBDE, and 0.01% for cadmium, or qualify for an exemption to above limits as defined in the Annex of the EU RoHS Directive. Note that any exemptions taken in this case would not include application specific exemptions (e.g. lead in solder for servers) as TE cannot determine where component products will be used.

Additionally, the part numbers that are identified as 5 of 6 compliant meet the material limits described above, except that these products have lead in the solderable interface only. These products may be suitable for use in an application that has an exemption for the use of lead in solder (e.g. servers, network infrastructure, etc).

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05 September 2012

中国电子信息产品环境信息  
China EIP Environmental Information



Restricted Materials Above Threshold

电子元件 (Electronic Component) 183636-1	有毒有害物质或元素 Hazardous Substance					
	铅 (Pb)	汞 (Hg)	镉 (Cd)	六价铬 (Cr6)	多溴联苯 (PBB)	多溴二苯醚 (PBDE)
电子元件 (Electronic Component)	X	O	O	O	O	O
<p>O: 表示该部件内有有毒有害物质含量在 SJ/T 11363-2006 标准规定的限量要求以下 Indicates that the concentration of the hazardous substance in the part is below the relevant threshold of the SJ/T 1136 3-2006 standard.</p> <p>X: 表示该部件内有有毒有害物质含量超出 SJ/T 11363-2006 标准规定的限量要求 Indicates that the concentration of the hazardous substance in the part is above the relevant threshold of the SJ/T 1136 3-2006 standard.</p>						

Description for part 183636-1:

INSERT CAT5E 2x 10/100BT /A

The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hex chrome, mercury, PBB, PBDE, and 0.01% for cadmium, or qualify for an exemption to above limits as defined in the Annex of the EU RoHS Directive. Note that any exemptions taken in this case would not include application specific exemptions (e.g. lead in solder for servers) as TE cannot determine where component products will be used.

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## Statement of Compliance

### Requested Part

05 September 2012

183641-1

( Part 1 of 1)

### INSERT CAT5E 10/100BT & ISDN /A

Status: Active

EU RoHS/ELV Code: 5 of 6 EU RoHS/ELV Compliant

Solder Process Capability Code: Not applicable for solder process capability

China RoHS:  Restricted Materials Above Threshold

Exemptions: 7(x) - Pb-Used for ELV, 5/6 parts

REACH Oct 2008 SvHC Compliance: Not reviewed for REACH October 2008 SvHC(s)

REACH Jan/Mar 2010 SvHC Compliance: Not reviewed for REACH Jan/Mar 2010 SvHC(s)

REACH June 2010 SvHC Compliance: Contains no REACH June 2010 SvHC(s)

REACH Dec 2010 SvHC Compliance: Contains no REACH December 2010 SvHC(s)

REACH June 2011 SvHC Compliance: Not reviewed for REACH June 2011 SvHC(s)

REACH December 2011 SvHC Compliance: Not reviewed for REACH December 2011 SvHC(s)

REACH June 2012 SvHC Compliance: Not reviewed for REACH June 2012 SvHC(s)

Halogen Content: Not Yet Reviewed for halogen content

David R. Bender

Director, Product Compliance

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The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hex chrome, mercury, PBB, PBDE, and 0.01% for cadmium, or qualify for an exemption to above limits as defined in the Annex of the EU RoHS Directive. Note that any exemptions taken in this case would not include application specific exemptions (e.g. lead in solder for servers) as TE cannot determine where component products will be used.

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05 September 2012

中国电子信息产品环境信息  
China EIP Environmental Information



Restricted Materials Above Threshold

电子元件 (Electronic Component) 183641-1	有毒有害物质或元素 Hazardous Substance					
	铅 (Pb)	汞 (Hg)	镉 (Cd)	六价铬 (Cr6)	多溴联苯 (PBB)	多溴二苯醚 (PBDE)
电子元件 (Electronic Component)	X	O	O	O	O	O
<p>O: 表示该部件内有有毒有害物质含量在 SJ/T 11363-2006 标准规定的限量要求以下 Indicates that the concentration of the hazardous substance in the part is below the relevant threshold of the SJ/T 1136 3-2006 standard.</p> <p>X: 表示该部件内有有毒有害物质含量超出 SJ/T 11363-2006 标准规定的限量要求 Indicates that the concentration of the hazardous substance in the part is above the relevant threshold of the SJ/T 1136 3-2006 standard.</p>						

Description for part 183641-1:

INSERT CAT5E 10/100BT & ISDN /A

The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hex chrome, mercury, PBB, PBDE, and 0.01% for cadmium, or qualify for an exemption to above limits as defined in the Annex of the EU RoHS Directive. Note that any exemptions taken in this case would not include application specific exemptions (e.g. lead in solder for servers) as TE cannot determine where component products will be used.

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## Statement of Compliance

### Requested Part

05 September 2012

183553-1


( Part 1 of 1)

INSERT Sub-D 9 pin /A

Status: Active

EU RoHS/ELV Code: 5 of 6 EU RoHS/ELV Compliant

Solder Process Capability Code: Not applicable for solder process capability

China RoHS:  Restricted Materials Above Threshold

Exemptions: 7(x) - Pb-Used for ELV, 5/6 parts

REACH Oct 2008 SvHC Compliance: Not reviewed for REACH October 2008 SvHC(s)

REACH Jan/Mar 2010 SvHC Compliance: Not reviewed for REACH Jan/Mar 2010 SvHC(s)

REACH June 2010 SvHC Compliance: Contains no REACH June 2010 SvHC(s)

REACH Dec 2010 SvHC Compliance: Contains no REACH December 2010 SvHC(s)

REACH June 2011 SvHC Compliance: Not reviewed for REACH June 2011 SvHC(s)

REACH December 2011 SvHC Compliance: Not reviewed for REACH December 2011 SvHC(s)

REACH June 2012 SvHC Compliance: Not reviewed for REACH June 2012 SvHC(s)

Halogen Content: Not Yet Reviewed for halogen content

David R. Bender

Director, Product Compliance

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The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hex chrome, mercury, PBB, PBDE, and 0.01% for cadmium, or qualify for an exemption to above limits as defined in the Annex of the EU RoHS Directive. Note that any exemptions taken in this case would not include application specific exemptions (e.g. lead in solder for servers) as TE cannot determine where component products will be used.

Additionally, the part numbers that are identified as 5 of 6 compliant meet the material limits described above, except that these products have lead in the solderable interface only. These products may be suitable for use in an application that has an exemption for the use of lead in solder (e.g. servers, network infrastructure, etc).

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05 September 2012

中国电子信息产品环境信息  
China EIP Environmental Information



Restricted Materials Above Threshold

电子元件 (Electronic Component) 183553-1	有毒有害物质或元素 Hazardous Substance					
	铅 (Pb)	汞 (Hg)	镉 (Cd)	六价铬 (Cr6)	多溴联苯 (PBB)	多溴二苯醚 (PBDE)
电子元件 (Electronic Component)	X	○	○	○	○	○
<p>O: 表示该部件内有有毒有害物质含量在 SJ/T 11363-2006 标准规定的限量要求以下 Indicates that the concentration of the hazardous substance in the part is below the relevant threshold of the SJ/T 1136 3-2006 standard.</p> <p>X: 表示该部件内有有毒有害物质含量超出 SJ/T 11363-2006 标准规定的限量要求 Indicates that the concentration of the hazardous substance in the part is above the relevant threshold of the SJ/T 1136 3-2006 standard.</p>						

Description for part 183553-1:

INSERT Sub-D 9 pin /A

The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hex chrome, mercury, PBB, PBDE, and 0.01% for cadmium, or qualify for an exemption to above limits as defined in the Annex of the EU RoHS Directive. Note that any exemptions taken in this case would not include application specific exemptions (e.g. lead in solder for servers) as TE cannot determine where component products will be used.

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## Statement of Compliance

### Requested Part

05 September 2012

183736-1

( Part 1 of 1)

INSERT 2x TEL /A

Status: Active

EU RoHS/ELV Code: 5 of 6 EU RoHS/ELV Compliant

Solder Process Capability Code: Not applicable for solder process capability

China RoHS:  Restricted Materials Above Threshold

Exemptions: 7(x) - Pb-Used for ELV, 5/6 parts

REACH Oct 2008 SvHC Compliance: Not reviewed for REACH October 2008 SvHC(s)

REACH Jan/Mar 2010 SvHC Compliance: Not reviewed for REACH Jan/Mar 2010 SvHC(s)

REACH June 2010 SvHC Compliance: Contains no REACH June 2010 SvHC(s)

REACH Dec 2010 SvHC Compliance: Contains no REACH December 2010 SvHC(s)

REACH June 2011 SvHC Compliance: Not reviewed for REACH June 2011 SvHC(s)

REACH December 2011 SvHC Compliance: Not reviewed for REACH December 2011 SvHC(s)

REACH June 2012 SvHC Compliance: Not reviewed for REACH June 2012 SvHC(s)

Halogen Content: Not Yet Reviewed for halogen content

David R. Bender

Director, Product Compliance

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The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hex chrome, mercury, PBB, PBDE, and 0.01% for cadmium, or qualify for an exemption to above limits as defined in the Annex of the EU RoHS Directive. Note that any exemptions taken in this case would not include application specific exemptions (e.g. lead in solder for servers) as TE cannot determine where component products will be used.

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05 September 2012

中国电子信息产品环境信息  
China EIP Environmental Information



Restricted Materials Above Threshold

电子元件 (Electronic Component) 183736-1	有毒有害物质或元素 Hazardous Substance					
	铅 (Pb)	汞 (Hg)	镉 (Cd)	六价铬 (Cr6)	多溴联苯 (PBB)	多溴二苯醚 (PBDE)
电子元件 (Electronic Component)	X	O	O	O	O	O
<p>O: 表示该部件内有有毒有害物质含量在 SJ/T 11363-2006 标准规定的限量要求以下 Indicates that the concentration of the hazardous substance in the part is below the relevant threshold of the SJ/T 1136 3-2006 standard.</p> <p>X: 表示该部件内有有毒有害物质含量超出 SJ/T 11363-2006 标准规定的限量要求 Indicates that the concentration of the hazardous substance in the part is above the relevant threshold of the SJ/T 1136 3-2006 standard.</p>						

Description for part 183736-1:

INSERT 2x TEL /A

The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hex chrome, mercury, PBB, PBDE, and 0.01% for cadmium, or qualify for an exemption to above limits as defined in the Annex of the EU RoHS Directive. Note that any exemptions taken in this case would not include application specific exemptions (e.g. lead in solder for servers) as TE cannot determine where component products will be used.

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## Statement of Compliance

### Requested Part

05 September 2012

1711609-1


( Part 1 of 1)

INSERT CAT7a ARJ45 style /A

Status: Active

EU RoHS/ELV Code: 5 of 6 EU RoHS/ELV Compliant

Solder Process Capability Code: Not applicable for solder process capability

China RoHS:  Restricted Materials Above Threshold

Exemptions: 7(x) - Pb-Used for ELV, 5/6 parts

REACH Oct 2008 SvHC Compliance: Not reviewed for REACH October 2008 SvHC(s)

REACH Jan/Mar 2010 SvHC Compliance: Not reviewed for REACH Jan/Mar 2010 SvHC(s)

REACH June 2010 SvHC Compliance: Contains no REACH June 2010 SvHC(s)

REACH Dec 2010 SvHC Compliance: Contains no REACH December 2010 SvHC(s)

REACH June 2011 SvHC Compliance: Not reviewed for REACH June 2011 SvHC(s)

REACH December 2011 SvHC Compliance: Not reviewed for REACH December 2011 SvHC(s)

REACH June 2012 SvHC Compliance: Not reviewed for REACH June 2012 SvHC(s)

Halogen Content: Not Yet Reviewed for halogen content

David R. Bender

Director, Product Compliance

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The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hex chrome, mercury, PBB, PBDE, and 0.01% for cadmium, or qualify for an exemption to above limits as defined in the Annex of the EU RoHS Directive. Note that any exemptions taken in this case would not include application specific exemptions (e.g. lead in solder for servers) as TE cannot determine where component products will be used.

Additionally, the part numbers that are identified as 5 of 6 compliant meet the material limits described above, except that these products have lead in the solderable interface only. These products may be suitable for use in an application that has an exemption for the use of lead in solder (e.g. servers, network infrastructure, etc).

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05 September 2012

中国电子信息产品环境信息  
China EIP Environmental Information



Restricted Materials Above Threshold

电子元件 (Electronic Component) 1711609-1	有毒有害物质或元素 Hazardous Substance					
	铅 (Pb)	汞 (Hg)	镉 (Cd)	六价铬 (Cr6)	多溴联苯 (PBB)	多溴二苯醚 (PBDE)
电子元件 (Electronic Component)	X	○	○	○	○	○
<p>○: 表示该部件内有有毒有害物质含量在 SJ/T 11363-2006 标准规定的限量要求以下 Indicates that the concentration of the hazardous substance in the part is below the relevant threshold of the SJ/T 1136 3-2006 standard.</p> <p>X: 表示该部件内有有毒有害物质含量超出 SJ/T 11363-2006 标准规定的限量要求 Indicates that the concentration of the hazardous substance in the part is above the relevant threshold of the SJ/T 1136 3-2006 standard.</p>						

Description for part 1711609-1:

INSERT CAT7a ARJ45 style /A

The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hex chrome, mercury, PBB, PBDE, and 0.01% for cadmium, or qualify for an exemption to above limits as defined in the Annex of the EU RoHS Directive. Note that any exemptions taken in this case would not include application specific exemptions (e.g. lead in solder for servers) as TE cannot determine where component products will be used.

Additionally, the part numbers that are identified as 5 of 6 compliant meet the material limits described above, except that these products have lead in the solderable interface only. These products may be suitable for use in an application that has an exemption for the use of lead in solder (e.g. servers, network infrastructure, etc).

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information provided by our suppliers. This information is subject to change.



Statement of Compliance

**Requested Part**

05 September 2012

1711409-1


( Part 1 of 1)

INSERT CAT7a AMPTWIST7aS style /A

Status: Active

EU RoHS/ELV Code: 5 of 6 EU RoHS/ELV Compliant

Solder Process Capability Code: Not applicable for solder process capability

China RoHS:  Restricted Materials Above Threshold

Exemptions: 6(c) - Pb-Alloy in Copper

7(x) - Pb-Used for ELV, 5/6 parts

REACH Oct 2008 SvHC Compliance: Not reviewed for REACH October 2008 SvHC(s)

REACH Jan/Mar 2010 SvHC Compliance: Not reviewed for REACH Jan/Mar 2010 SvHC(s)

REACH June 2010 SvHC Compliance: Contains no REACH June 2010 SvHC(s)

REACH Dec 2010 SvHC Compliance: Contains no REACH December 2010 SvHC(s)

REACH June 2011 SvHC Compliance: Not reviewed for REACH June 2011 SvHC(s)

REACH December 2011 SvHC Compliance: Not reviewed for REACH December 2011 SvHC(s)

REACH June 2012 SvHC Compliance: Not reviewed for REACH June 2012 SvHC(s)

Halogen Content: Not Yet Reviewed for halogen content

David R. Bender

Director, Product Compliance

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The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hex chrome, mercury, PBB, PBDE, and 0.01% for cadmium, or qualify for an exemption to above limits as defined in the Annex of the EU RoHS Directive. Note that any exemptions taken in this case would not include application specific exemptions (e.g. lead in solder for servers) as TE cannot determine where component products will be used.

Additionally, the part numbers that are identified as 5 of 6 compliant meet the material limits described above, except that these products have lead in the solderable interface only. These products may be suitable for use in an application that has an exemption for the use of lead in solder (e.g. servers, network infrastructure, etc).

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information provided by our suppliers. This information is subject to change.



05 September 2012

中国电子信息产品环境信息  
China EIP Environmental Information



Restricted Materials Above Threshold

电子元件 (Electronic Component) 1711409-1	有毒有害物质或元素 Hazardous Substance					
	铅 (Pb)	汞 (Hg)	镉 (Cd)	六价铬 (Cr6)	多溴联苯 (PBB)	多溴二苯醚 (PBDE)
电子元件 (Electronic Component)	X	O	O	O	O	O

O: 表示该部件内有有毒有害物质含量在 SJ/T 11363-2006 标准规定的限量要求以下  
Indicates that the concentration of the hazardous substance in the part is below the relevant threshold of the SJ/T 1136 3-2006 standard.

X: 表示该部件内有有毒有害物质含量超出 SJ/T 11363-2006 标准规定的限量要求  
Indicates that the concentration of the hazardous substance in the part is above the relevant threshold of the SJ/T 1136 3-2006 standard.

Description for part 1711409-1:

INSERT CAT7a AMPTWIST7aS style /A

The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hex chrome, mercury, PBB, PBDE, and 0.01% for cadmium, or qualify for an exemption to above limits as defined in the Annex of the EU RoHS Directive. Note that any exemptions taken in this case would not include application specific exemptions (e.g. lead in solder for servers) as TE cannot determine where component products will be used.

Additionally, the part numbers that are identified as 5 of 6 compliant meet the material limits described above, except that these products have lead in the solderable interface only. These products may be suitable for use in an application that has an exemption for the use of lead in solder (e.g. servers, network infrastructure, etc).

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## Statement of Compliance

### Requested Part

05 September 2012

336548-1

( Part 1 of 1)

INSERT CAT6 1x RJ45 T568A /A

Status: Active

EU RoHS/ELV Code: 5 of 6 EU RoHS/ELV Compliant

Solder Process Capability Code: Not applicable for solder process capability

China RoHS:  Restricted Materials Above Threshold

Exemptions: 7(x) - Pb-Used for ELV, 5/6 parts

REACH Oct 2008 SvHC Compliance: Not reviewed for REACH October 2008 SvHC(s)

REACH Jan/Mar 2010 SvHC Compliance: Not reviewed for REACH Jan/Mar 2010 SvHC(s)

REACH June 2010 SvHC Compliance: Contains no REACH June 2010 SvHC(s)

REACH Dec 2010 SvHC Compliance: Contains no REACH December 2010 SvHC(s)

REACH June 2011 SvHC Compliance: Not reviewed for REACH June 2011 SvHC(s)

REACH December 2011 SvHC Compliance: Not reviewed for REACH December 2011 SvHC(s)

REACH June 2012 SvHC Compliance: Not reviewed for REACH June 2012 SvHC(s)

Halogen Content: Not Yet Reviewed for halogen content

David R. Bender

Director, Product Compliance

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The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hex chrome, mercury, PBB, PBDE, and 0.01% for cadmium, or qualify for an exemption to above limits as defined in the Annex of the EU RoHS Directive. Note that any exemptions taken in this case would not include application specific exemptions (e.g. lead in solder for servers) as TE cannot determine where component products will be used.

Additionally, the part numbers that are identified as 5 of 6 compliant meet the material limits described above, except that these products have lead in the solderable interface only. These products may be suitable for use in an application that has an exemption for the use of lead in solder (e.g. servers, network infrastructure, etc).

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information provided by our suppliers. This information is subject to change.





05 September 2012

中国电子信息产品环境信息  
China EIP Environmental Information



Restricted Materials Above Threshold

电子元件 (Electronic Component) 336548-1	有毒有害物质或元素 Hazardous Substance					
	铅 (Pb)	汞 (Hg)	镉 (Cd)	六价铬 (Cr6)	多溴联苯 (PBB)	多溴二苯醚 (PBDE)
电子元件 (Electronic Component)	X	O	O	O	O	O
<p>O: 表示该部件内有有毒有害物质含量在 SJ/T 11363-2006 标准规定的限量要求以下 Indicates that the concentration of the hazardous substance in the part is below the relevant threshold of the SJ/T 1136 3-2006 standard.</p> <p>X: 表示该部件内有有毒有害物质含量超出 SJ/T 11363-2006 标准规定的限量要求 Indicates that the concentration of the hazardous substance in the part is above the relevant threshold of the SJ/T 1136 3-2006 standard.</p>						

Description for part 336548-1:

INSERT CAT6 1x RJ45 T568A /A

The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hex chrome, mercury, PBB, PBDE, and 0.01% for cadmium, or qualify for an exemption to above limits as defined in the Annex of the EU RoHS Directive. Note that any exemptions taken in this case would not include application specific exemptions (e.g. lead in solder for servers) as TE cannot determine where component products will be used.

Additionally, the part numbers that are identified as 5 of 6 compliant meet the material limits described above, except that these products have lead in the solderable interface only. These products may be suitable for use in an application that has an exemption for the use of lead in solder (e.g. servers, network infrastructure, etc).

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## Statement of Compliance

### Requested Part

05 September 2012

284584-1


( Part 1 of 1)

INSERT CAT5E 1x RJ45 T568A /A

Status: Active

EU RoHS/ELV Code: 5 of 6 EU RoHS/ELV Compliant

Solder Process Capability Code: Not applicable for solder process capability

China RoHS:  Restricted Materials Above Threshold

Exemptions: 7(x) - Pb-Used for ELV, 5/6 parts

REACH Oct 2008 SvHC Compliance: Not reviewed for REACH October 2008 SvHC(s)

REACH Jan/Mar 2010 SvHC Compliance: Not reviewed for REACH Jan/Mar 2010 SvHC(s)

REACH June 2010 SvHC Compliance: Contains no REACH June 2010 SvHC(s)

REACH Dec 2010 SvHC Compliance: Contains no REACH December 2010 SvHC(s)

REACH June 2011 SvHC Compliance: Not reviewed for REACH June 2011 SvHC(s)

REACH December 2011 SvHC Compliance: Not reviewed for REACH December 2011 SvHC(s)

REACH June 2012 SvHC Compliance: Not reviewed for REACH June 2012 SvHC(s)

Halogen Content: Not Yet Reviewed for halogen content

David R. Bender

Director, Product Compliance

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The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hex chrome, mercury, PBB, PBDE, and 0.01% for cadmium, or qualify for an exemption to above limits as defined in the Annex of the EU RoHS Directive. Note that any exemptions taken in this case would not include application specific exemptions (e.g. lead in solder for servers) as TE cannot determine where component products will be used.

Additionally, the part numbers that are identified as 5 of 6 compliant meet the material limits described above, except that these products have lead in the solderable interface only. These products may be suitable for use in an application that has an exemption for the use of lead in solder (e.g. servers, network infrastructure, etc).

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05 September 2012

中国电子信息产品环境信息  
China EIP Environmental Information



Restricted Materials Above Threshold

电子元件 (Electronic Component) 284584-1	有毒有害物质或元素 Hazardous Substance					
	铅 (Pb)	汞 (Hg)	镉 (Cd)	六价铬 (Cr6)	多溴联苯 (PBB)	多溴二苯醚 (PBDE)
电子元件 (Electronic Component)	X	O	O	O	O	O
<p>O: 表示该部件内有有毒有害物质含量在 SJ/T 11363-2006 标准规定的限量要求以下 Indicates that the concentration of the hazardous substance in the part is below the relevant threshold of the SJ/T 1136 3-2006 standard.</p> <p>X: 表示该部件内有有毒有害物质含量超出 SJ/T 11363-2006 标准规定的限量要求 Indicates that the concentration of the hazardous substance in the part is above the relevant threshold of the SJ/T 1136 3-2006 standard.</p>						

Description for part 284584-1:

INSERT CAT5E 1x RJ45 T568A /A

The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hex chrome, mercury, PBB, PBDE, and 0.01% for cadmium, or qualify for an exemption to above limits as defined in the Annex of the EU RoHS Directive. Note that any exemptions taken in this case would not include application specific exemptions (e.g. lead in solder for servers) as TE cannot determine where component products will be used.

Additionally, the part numbers that are identified as 5 of 6 compliant meet the material limits described above, except that these products have lead in the solderable interface only. These products may be suitable for use in an application that has an exemption for the use of lead in solder (e.g. servers, network infrastructure, etc).

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## Statement of Compliance

### Requested Part

05 September 2012

336554-1

( Part 1 of 1)

INSERT CAT6 2x ISDN /A

Status: Superseded

EU RoHS/ELV Code: 5 of 6 EU RoHS/ELV Compliant

Solder Process Capability Code: Not applicable for solder process capability

China RoHS:  Restricted Materials Above Threshold

Exemptions: 7(x) - Pb-Used for ELV, 5/6 parts

REACH Oct 2008 SvHC Compliance: Not reviewed for REACH October 2008 SvHC(s)

REACH Jan/Mar 2010 SvHC Compliance: Not reviewed for REACH Jan/Mar 2010 SvHC(s)

REACH June 2010 SvHC Compliance: Contains no REACH June 2010 SvHC(s)

REACH Dec 2010 SvHC Compliance: Contains no REACH December 2010 SvHC(s)

REACH June 2011 SvHC Compliance: Not reviewed for REACH June 2011 SvHC(s)

REACH December 2011 SvHC Compliance: Not reviewed for REACH December 2011 SvHC(s)

REACH June 2012 SvHC Compliance: Not reviewed for REACH June 2012 SvHC(s)

Halogen Content: Not Yet Reviewed for halogen content

David R. Bender

Director, Product Compliance

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The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hex chrome, mercury, PBB, PBDE, and 0.01% for cadmium, or qualify for an exemption to above limits as defined in the Annex of the EU RoHS Directive. Note that any exemptions taken in this case would not include application specific exemptions (e.g. lead in solder for servers) as TE cannot determine where component products will be used.

Additionally, the part numbers that are identified as 5 of 6 compliant meet the material limits described above, except that these products have lead in the solderable interface only. These products may be suitable for use in an application that has an exemption for the use of lead in solder (e.g. servers, network infrastructure, etc).

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**RoHS Equivalent Part(s) for Part 336554-1**

05 September 2012

1711807-1

(Equivalent Part 1 of 1)

INSERT CAT6a 2x ISDN /A

Status: Active

EU RoHS/ELV Code: Always EU RoHS/ELV Compliant

Solder Process Capability Code: Not applicable for solder process capability

China RoHS:  No Restricted Materials Above Threshold

Exemptions: No Substance>Threshold

REACH Oct 2008 SvHC Compliance: Not reviewed for REACH October 2008 SvHC(s)

REACH Jan/Mar 2010 SvHC Compliance: Not reviewed for REACH Jan/Mar 2010 SvHC(s)

REACH June 2010 SvHC Compliance: Contains no REACH June 2010 SvHC(s)

REACH Dec 2010 SvHC Compliance: Contains no REACH December 2010 SvHC(s)

REACH June 2011 SvHC Compliance: Not reviewed for REACH June 2011 SvHC(s)

REACH December 2011 SvHC Compliance: Not reviewed for REACH December 2011 SvHC(s)

REACH June 2012 SvHC Compliance: Not reviewed for REACH June 2012 SvHC(s)

Halogen Content: Not Yet Reviewed for halogen content

Description of Difference: New Cat6A Inserts

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The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hex chrome, mercury, PBB, PBDE, and 0.01% for cadmium, or qualify for an exemption to above limits as defined in the Annex of the EU RoHS Directive. Note that any exemptions taken in this case would not include application specific exemptions (e.g. lead in solder for servers) as TE cannot determine where component products will be used.

Additionally, the part numbers that are identified as 5 of 6 compliant meet the material limits described above, except that these products have lead in the solderable interface only. These products may be suitable for use in an application that has an exemption for the use of lead in solder (e.g. servers, network infrastructure, etc).

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05 September 2012

中国电子信息产品环境信息  
China EIP Environmental Information



Restricted Materials Above Threshold

电子元件 (Electronic Component) 336554-1	有毒有害物质或元素 Hazardous Substance					
	铅 (Pb)	汞 (Hg)	镉 (Cd)	六价铬 (Cr6)	多溴联苯 (PBB)	多溴二苯醚 (PBDE)
电子元件 (Electronic Component)	X	O	O	O	O	O
<p>O: 表示该部件内有有毒有害物质含量在 SJ/T 11363-2006 标准规定的限量要求以下 Indicates that the concentration of the hazardous substance in the part is below the relevant threshold of the SJ/T 1136 3-2006 standard.</p> <p>X: 表示该部件内有有毒有害物质含量超出 SJ/T 11363-2006 标准规定的限量要求 Indicates that the concentration of the hazardous substance in the part is above the relevant threshold of the SJ/T 1136 3-2006 standard.</p>						

Description for part 336554-1:

INSERT CAT6 2x ISDN /A

The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hex chrome, mercury, PBB, PBDE, and 0.01% for cadmium, or qualify for an exemption to above limits as defined in the Annex of the EU RoHS Directive. Note that any exemptions taken in this case would not include application specific exemptions (e.g. lead in solder for servers) as TE cannot determine where component products will be used.

Additionally, the part numbers that are identified as 5 of 6 compliant meet the material limits described above, except that these products have lead in the solderable interface only. These products may be suitable for use in an application that has an exemption for the use of lead in solder (e.g. servers, network infrastructure, etc).

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## Statement of Compliance

### Requested Part

05 September 2012

336553-1

( Part 1 of 1)

INSERT CAT6 2x 10/100BT /A

Status: Superseded

EU RoHS/ELV Code: 5 of 6 EU RoHS/ELV Compliant

Solder Process Capability Code: Not applicable for solder process capability

China RoHS:  Restricted Materials Above Threshold

Exemptions: 7(x) - Pb-Used for ELV, 5/6 parts

REACH Oct 2008 SvHC Compliance: Not reviewed for REACH October 2008 SvHC(s)

REACH Jan/Mar 2010 SvHC Compliance: Not reviewed for REACH Jan/Mar 2010 SvHC(s)

REACH June 2010 SvHC Compliance: Contains no REACH June 2010 SvHC(s)

REACH Dec 2010 SvHC Compliance: Contains no REACH December 2010 SvHC(s)

REACH June 2011 SvHC Compliance: Not reviewed for REACH June 2011 SvHC(s)

REACH December 2011 SvHC Compliance: Not reviewed for REACH December 2011 SvHC(s)

REACH June 2012 SvHC Compliance: Not reviewed for REACH June 2012 SvHC(s)

Halogen Content: Not Yet Reviewed for halogen content

David R. Bender

Director, Product Compliance

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The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hex chrome, mercury, PBB, PBDE, and 0.01% for cadmium, or qualify for an exemption to above limits as defined in the Annex of the EU RoHS Directive. Note that any exemptions taken in this case would not include application specific exemptions (e.g. lead in solder for servers) as TE cannot determine where component products will be used.

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**RoHS Equivalent Part(s) for Part 338553-1**

05 September 2012

1711801-1

(Equivalent Part 1 of 1)

INSERT CAT6a 2x 10/100BT /A

Status: Active

EU RoHS/ELV Code: Always EU RoHS/ELV Compliant

Solder Process Capability Code: Not applicable for solder process capability

China RoHS:  No Restricted Materials Above Threshold

Exemptions: No Substance>Threshold

REACH Oct 2008 SvHC Compliance: Not reviewed for REACH October 2008 SvHC(s)

REACH Jan/Mar 2010 SvHC Compliance: Not reviewed for REACH Jan/Mar 2010 SvHC(s)

REACH June 2010 SvHC Compliance: Contains no REACH June 2010 SvHC(s)

REACH Dec 2010 SvHC Compliance: Contains no REACH December 2010 SvHC(s)

REACH June 2011 SvHC Compliance: Not reviewed for REACH June 2011 SvHC(s)

REACH December 2011 SvHC Compliance: Not reviewed for REACH December 2011 SvHC(s)

REACH June 2012 SvHC Compliance: Not reviewed for REACH June 2012 SvHC(s)

Halogen Content: Not Yet Reviewed for halogen content

Description of Difference: New Cat6A Inserts

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The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hex chrome, mercury, PBB, PBDE, and 0.01% for cadmium, or qualify for an exemption to above limits as defined in the Annex of the EU RoHS Directive. Note that any exemptions taken in this case would not include application specific exemptions (e.g. lead in solder for servers) as TE cannot determine where component products will be used.

Additionally, the part numbers that are identified as 5 of 6 compliant meet the material limits described above, except that these products have lead in the solderable interface only. These products may be suitable for use in an application that has an exemption for the use of lead in solder (e.g. servers, network infrastructure, etc).

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05 September 2012

中国电子信息产品环境信息  
China EIP Environmental Information



Restricted Materials Above Threshold

电子元件 (Electronic Component) 336553-1	有毒有害物质或元素 Hazardous Substance					
	铅 (Pb)	汞 (Hg)	镉 (Cd)	六价铬 (Cr6)	多溴联苯 (PBB)	多溴二苯醚 (PBDE)
电子元件 (Electronic Component)	X	O	O	O	O	O
<p>O: 表示该部件内有有毒有害物质含量在 SJ/T 11363-2006 标准规定的限量要求以下 Indicates that the concentration of the hazardous substance in the part is below the relevant threshold of the SJ/T 1136 3-2006 standard.</p> <p>X: 表示该部件内有有毒有害物质含量超出 SJ/T 11363-2006 标准规定的限量要求 Indicates that the concentration of the hazardous substance in the part is above the relevant threshold of the SJ/T 1136 3-2006 standard.</p>						

Description for part 336553-1:

INSERT CAT6 2x 10/100BT /A

The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hex chrome, mercury, PBB, PBDE, and 0.01% for cadmium, or qualify for an exemption to above limits as defined in the Annex of the EU RoHS Directive. Note that any exemptions taken in this case would not include application specific exemptions (e.g. lead in solder for servers) as TE cannot determine where component products will be used.

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## Statement of Compliance

### Requested Part

05 September 2012

5492643-1

( Part 1 of 1)

CONN KIT, +SC 62.5/125

Status: Active

EU RoHS/ELV Code: Not in Scope for EU RoHS/ELV Compliance

Solder Process Capability Code: Not applicable for solder process capability

China RoHS:  Restricted Materials Above Threshold

Exemptions: 6(c) - Pb-Alloy in Copper

REACH Oct 2008 SvHC Compliance: Contains REACH October 2008 SvHC(s)

SvHC 1: Bis(tributyltin)oxide (CAS No: 56-35-9) @ 20.00 % wt

REACH Jan/Mar 2010 SvHC Compliance: Not reviewed for REACH Jan/Mar 2010 SvHC(s)

REACH June 2010 SvHC Compliance: Contains no REACH June 2010 SvHC(s)

REACH Dec 2010 SvHC Compliance: Contains no REACH December 2010 SvHC(s)

REACH June 2011 SvHC Compliance: Not reviewed for REACH June 2011 SvHC(s)

REACH December 2011 SvHC Compliance: Not reviewed for REACH December 2011 SvHC(s)

REACH June 2012 SvHC Compliance: Not reviewed for REACH June 2012 SvHC(s)

Halogen Content: Not Yet Reviewed for halogen content

David R. Bender

Director, Product Compliance

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The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hex chrome, mercury, PBB, PBDE, and 0.01% for cadmium, or qualify for an exemption to above limits as defined in the Annex of the EU RoHS Directive. Note that any exemptions taken in this case would not include application specific exemptions (e.g. lead in solder for servers) as TE cannot determine where component products will be used.

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05 September 2012

中国电子信息产品环境信息  
China EIP Environmental Information



Restricted Materials Above Threshold

电子元件 (Electronic Component) 5492643-1	有毒有害物质或元素 Hazardous Substance					
	铅 (Pb)	汞 (Hg)	镉 (Cd)	六价铬 (Cr6)	多溴联苯 (PBB)	多溴二苯醚 (PBDE)
电子元件 (Electronic Component)	X	O	O	O	O	O
<p>O: 表示该部件内有有毒有害物质含量在 SJ/T 11363-2006 标准规定的限量要求以下 Indicates that the concentration of the hazardous substance in the part is below the relevant threshold of the SJ/T 1136 3-2006 standard.</p> <p>X: 表示该部件内有有毒有害物质含量超出 SJ/T 11363-2006 标准规定的限量要求 Indicates that the concentration of the hazardous substance in the part is above the relevant threshold of the SJ/T 1136 3-2006 standard.</p>						

Description for part 5492643-1:

CONN KIT, +SC 62.5/125

The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hex chrome, mercury, PBB, PBDE, and 0.01% for cadmium, or qualify for an exemption to above limits as defined in the Annex of the EU RoHS Directive. Note that any exemptions taken in this case would not include application specific exemptions (e.g. lead in solder for servers) as TE cannot determine where component products will be used.

Additionally, the part numbers that are identified as 5 of 6 compliant meet the material limits described above, except that these products have lead in the solderable interface only. These products may be suitable for use in an application that has an exemption for the use of lead in solder (e.g. servers, network infrastructure, etc).

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information provided by our suppliers. This information is subject to change.



## Statement of Compliance

### Requested Part

05 September 2012

336549-1

( Part 1 of 1)

### INSERT CAT6 10/100BT & ISDN /A

Status: Superseded

EU RoHS/ELV Code: 5 of 6 EU RoHS/ELV Compliant

Solder Process Capability Code: Not applicable for solder process capability

China RoHS:  Restricted Materials Above Threshold

Exemptions: 7(x) - Pb-Used for ELV, 5/6 parts

REACH Oct 2008 SvHC Compliance: Not reviewed for REACH October 2008 SvHC(s)

REACH Jan/Mar 2010 SvHC Compliance: Not reviewed for REACH Jan/Mar 2010 SvHC(s)

REACH June 2010 SvHC Compliance: Contains no REACH June 2010 SvHC(s)

REACH Dec 2010 SvHC Compliance: Contains no REACH December 2010 SvHC(s)

REACH June 2011 SvHC Compliance: Not reviewed for REACH June 2011 SvHC(s)

REACH December 2011 SvHC Compliance: Not reviewed for REACH December 2011 SvHC(s)

REACH June 2012 SvHC Compliance: Not reviewed for REACH June 2012 SvHC(s)

Halogen Content: Not Yet Reviewed for halogen content

David R. Bender

Director, Product Compliance

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The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hex chrome, mercury, PBB, PBDE, and 0.01% for cadmium, or qualify for an exemption to above limits as defined in the Annex of the EU RoHS Directive. Note that any exemptions taken in this case would not include application specific exemptions (e.g. lead in solder for servers) as TE cannot determine where component products will be used.

Additionally, the part numbers that are identified as 5 of 6 compliant meet the material limits described above, except that these products have lead in the solderable interface only. These products may be suitable for use in an application that has an exemption for the use of lead in solder (e.g. servers, network infrastructure, etc).

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information provided by our suppliers. This information is subject to change.



**RoHS Equivalent Part(s) for Part 338549-1**

05 September 2012

**1711804-1**

(Equivalent Part 1 of 1)

INSERT CAT6a 10/100BT & ISDN /A

Status: Active

EU RoHS/ELV Code: Always EU RoHS/ELV Compliant

Solder Process Capability Code: Not applicable for solder process capability

China RoHS:  No Restricted Materials Above Threshold

Exemptions: No Substance>Threshold

REACH Oct 2008 SvHC Compliance: Not reviewed for REACH October 2008 SvHC(s)

REACH Jan/Mar 2010 SvHC Compliance: Not reviewed for REACH Jan/Mar 2010 SvHC(s)

REACH June 2010 SvHC Compliance: Contains no REACH June 2010 SvHC(s)

REACH Dec 2010 SvHC Compliance: Contains no REACH December 2010 SvHC(s)

REACH June 2011 SvHC Compliance: Not reviewed for REACH June 2011 SvHC(s)

REACH December 2011 SvHC Compliance: Not reviewed for REACH December 2011 SvHC(s)

REACH June 2012 SvHC Compliance: Not reviewed for REACH June 2012 SvHC(s)

Halogen Content: Not Yet Reviewed for halogen content

Description of Difference: New Cat6A Inserts

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The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hex chrome, mercury, PBB, PBDE, and 0.01% for cadmium, or qualify for an exemption to above limits as defined in the Annex of the EU RoHS Directive. Note that any exemptions taken in this case would not include application specific exemptions (e.g. lead in solder for servers) as TE cannot determine where component products will be used.

Additionally, the part numbers that are identified as 5 of 6 compliant meet the material limits described above, except that these products have lead in the solderable interface only. These products may be suitable for use in an application that has an exemption for the use of lead in solder (e.g. servers, network infrastructure, etc).

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information provided by our suppliers. This information is subject to change.



05 September 2012

中国电子信息产品环境信息  
China EIP Environmental Information



Restricted Materials Above Threshold

电子元件 (Electronic Component) 336549-1	有毒有害物质或元素 Hazardous Substance					
	铅 (Pb)	汞 (Hg)	镉 (Cd)	六价铬 (Cr6)	多溴联苯 (PBB)	多溴二苯醚 (PBDE)
电子元件 (Electronic Component)	X	O	O	O	O	O

O: 表示该部件内有有毒有害物质含量在 SJ/T 11363-2006 标准规定的限量要求以下  
Indicates that the concentration of the hazardous substance in the part is below the relevant threshold of the SJ/T 1136 3-2006 standard.

X: 表示该部件内有有毒有害物质含量超出 SJ/T 11363-2006 标准规定的限量要求  
Indicates that the concentration of the hazardous substance in the part is above the relevant threshold of the SJ/T 1136 3-2006 standard.

Description for part 336549-1:

INSERT CAT6 10/100BT & ISDN /A

The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hex chrome, mercury, PBB, PBDE, and 0.01% for cadmium, or qualify for an exemption to above limits as defined in the Annex of the EU RoHS Directive. Note that any exemptions taken in this case would not include application specific exemptions (e.g. lead in solder for servers) as TE cannot determine where component products will be used.

Additionally, the part numbers that are identified as 5 of 6 compliant meet the material limits described above, except that these products have lead in the solderable interface only. These products may be suitable for use in an application that has an exemption for the use of lead in solder (e.g. servers, network infrastructure, etc).

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information provided by our suppliers. This information is subject to change.



## Statement of Compliance

### Requested Part

05 September 2012

1711188-1

( Part 1 of 1)

INSERT 1x RJ45 10 GBE /A

Status: Superseded

EU RoHS/ELV Code: 5 of 6 EU RoHS/ELV Compliant

Solder Process Capability Code: Not applicable for solder process capability

China RoHS:  Restricted Materials Above Threshold

Exemptions: 7(x) - Pb-Used for ELV, 5/6 parts

REACH Oct 2008 SvHC Compliance: Not reviewed for REACH October 2008 SvHC(s)

REACH Jan/Mar 2010 SvHC Compliance: Not reviewed for REACH Jan/Mar 2010 SvHC(s)

REACH June 2010 SvHC Compliance: Contains no REACH June 2010 SvHC(s)

REACH Dec 2010 SvHC Compliance: Contains no REACH December 2010 SvHC(s)

REACH June 2011 SvHC Compliance: Not reviewed for REACH June 2011 SvHC(s)

REACH December 2011 SvHC Compliance: Not reviewed for REACH December 2011 SvHC(s)

REACH June 2012 SvHC Compliance: Not reviewed for REACH June 2012 SvHC(s)

Halogen Content: Not Yet Reviewed for halogen content

David R. Bender

Director, Product Compliance

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The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hex chrome, mercury, PBB, PBDE, and 0.01% for cadmium, or qualify for an exemption to above limits as defined in the Annex of the EU RoHS Directive. Note that any exemptions taken in this case would not include application specific exemptions (e.g. lead in solder for servers) as TE cannot determine where component products will be used.

Additionally, the part numbers that are identified as 5 of 6 compliant meet the material limits described above, except that these products have lead in the solderable interface only. These products may be suitable for use in an application that has an exemption for the use of lead in solder (e.g. servers, network infrastructure, etc).

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information provided by our suppliers. This information is subject to change.



**RoHS Equivalent Part(s) for Part 1711188-1**

05 September 2012

**1711796-1**

(Equivalent Part 1 of 1)

INSERT CAT6a 1x RJ45 T568A /A

Status: Active

EU RoHS/ELV Code: Always EU RoHS/ELV Compliant

Solder Process Capability Code: Not applicable for solder process capability

China RoHS:  No Restricted Materials Above Threshold

Exemptions: No Substance>Threshold

REACH Oct 2008 SvHC Compliance: Not reviewed for REACH October 2008 SvHC(s)

REACH Jan/Mar 2010 SvHC Compliance: Not reviewed for REACH Jan/Mar 2010 SvHC(s)

REACH June 2010 SvHC Compliance: Contains no REACH June 2010 SvHC(s)

REACH Dec 2010 SvHC Compliance: Contains no REACH December 2010 SvHC(s)

REACH June 2011 SvHC Compliance: Not reviewed for REACH June 2011 SvHC(s)

REACH December 2011 SvHC Compliance: Not reviewed for REACH December 2011 SvHC(s)

REACH June 2012 SvHC Compliance: Not reviewed for REACH June 2012 SvHC(s)

Halogen Content: Not Yet Reviewed for halogen content

Description of Difference: New AMP CO Cat6A Inserts

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The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hex chrome, mercury, PBB, PBDE, and 0.01% for cadmium, or qualify for an exemption to above limits as defined in the Annex of the EU RoHS Directive. Note that any exemptions taken in this case would not include application specific exemptions (e.g. lead in solder for servers) as TE cannot determine where component products will be used.

Additionally, the part numbers that are identified as 5 of 6 compliant meet the material limits described above, except that these products have lead in the solderable interface only. These products may be suitable for use in an application that has an exemption for the use of lead in solder (e.g. servers, network infrastructure, etc).

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information provided by our suppliers. This information is subject to change.





05 September 2012

中国电子信息产品环境信息  
China EIP Environmental Information



Restricted Materials Above Threshold

电子元件 (Electronic Component) 1711188-1	有毒有害物质或元素 Hazardous Substance					
	铅 (Pb)	汞 (Hg)	镉 (Cd)	六价铬 (Cr6)	多溴联苯 (PBB)	多溴二苯醚 (PBDE)
电子元件 (Electronic Component)	X	O	O	O	O	O
<p>O: 表示该部件内有有毒有害物质含量在 SJ/T 11363-2006 标准规定的限量要求以下 Indicates that the concentration of the hazardous substance in the part is below the relevant threshold of the SJ/T 1136 3-2006 standard.</p> <p>X: 表示该部件内有有毒有害物质含量超出 SJ/T 11363-2006 标准规定的限量要求 Indicates that the concentration of the hazardous substance in the part is above the relevant threshold of the SJ/T 1136 3-2006 standard.</p>						

Description for part 1711188-1:

INSERT 1x RJ45 10 GBE /A

The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hex chrome, mercury, PBB, PBDE, and 0.01% for cadmium, or qualify for an exemption to above limits as defined in the Annex of the EU RoHS Directive. Note that any exemptions taken in this case would not include application specific exemptions (e.g. lead in solder for servers) as TE cannot determine where component products will be used.

Additionally, the part numbers that are identified as 5 of 6 compliant meet the material limits described above, except that these products have lead in the solderable interface only. These products may be suitable for use in an application that has an exemption for the use of lead in solder (e.g. servers, network infrastructure, etc).

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## Statement of Compliance

### Requested Part

05 September 2012

1711609-5

( Part 1 of 1)

### INSERT CAT7a ARJ45 style IW

Status: Active

EU RoHS/ELV Code: 5 of 6 EU RoHS/ELV Compliant

Solder Process Capability Code: Not applicable for solder process capability

China RoHS:  Restricted Materials Above Threshold

Exemptions: 7(x) - Pb-Used for ELV, 5/6 parts

REACH Oct 2008 SvHC Compliance: Not reviewed for REACH October 2008 SvHC(s)

REACH Jan/Mar 2010 SvHC Compliance: Not reviewed for REACH Jan/Mar 2010 SvHC(s)

REACH June 2010 SvHC Compliance: Contains no REACH June 2010 SvHC(s)

REACH Dec 2010 SvHC Compliance: Contains no REACH December 2010 SvHC(s)

REACH June 2011 SvHC Compliance: Not reviewed for REACH June 2011 SvHC(s)

REACH December 2011 SvHC Compliance: Not reviewed for REACH December 2011 SvHC(s)

REACH June 2012 SvHC Compliance: Not reviewed for REACH June 2012 SvHC(s)

Halogen Content: Not Yet Reviewed for halogen content

David R. Bender

Director, Product Compliance

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The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hex chrome, mercury, PBB, PBDE, and 0.01% for cadmium, or qualify for an exemption to above limits as defined in the Annex of the EU RoHS Directive. Note that any exemptions taken in this case would not include application specific exemptions (e.g. lead in solder for servers) as TE cannot determine where component products will be used.

Additionally, the part numbers that are identified as 5 of 6 compliant meet the material limits described above, except that these products have lead in the solderable interface only. These products may be suitable for use in an application that has an exemption for the use of lead in solder (e.g. servers, network infrastructure, etc).

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information provided by our suppliers. This information is subject to change.



05 September 2012

中国电子信息产品环境信息  
China EIP Environmental Information



Restricted Materials Above Threshold

电子元件 (Electronic Component) 1711609-5	有毒有害物质或元素 Hazardous Substance					
	铅 (Pb)	汞 (Hg)	镉 (Cd)	六价铬 (Cr6)	多溴联苯 (PBB)	多溴二苯醚 (PBDE)
电子元件 (Electronic Component)	X	O	O	O	O	O
<p>O: 表示该部件内有有毒有害物质含量在 SJ/T 11363-2006 标准规定的限量要求以下 Indicates that the concentration of the hazardous substance in the part is below the relevant threshold of the SJ/T 1136 3-2006 standard.</p> <p>X: 表示该部件内有有毒有害物质含量超出 SJ/T 11363-2006 标准规定的限量要求 Indicates that the concentration of the hazardous substance in the part is above the relevant threshold of the SJ/T 1136 3-2006 standard.</p>						

Description for part 1711609-5:

INSERT CAT7a ARJ45 style /W

The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hex chrome, mercury, PBB, PBDE, and 0.01% for cadmium, or qualify for an exemption to above limits as defined in the Annex of the EU RoHS Directive. Note that any exemptions taken in this case would not include application specific exemptions (e.g. lead in solder for servers) as TE cannot determine where component products will be used.

Additionally, the part numbers that are identified as 5 of 6 compliant meet the material limits described above, except that these products have lead in the solderable interface only. These products may be suitable for use in an application that has an exemption for the use of lead in solder (e.g. servers, network infrastructure, etc).

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## Statement of Compliance

### Requested Part

05 September 2012

1711609-3

( Part 1 of 1)

INSERT CAT7a ARJ45 style /B

Status: Active

EU RoHS/ELV Code: 5 of 6 EU RoHS/ELV Compliant

Solder Process Capability Code: Not applicable for solder process capability

China RoHS:  Restricted Materials Above Threshold

Exemptions: 7(x) - Pb-Used for ELV, 5/6 parts

REACH Oct 2008 SvHC Compliance: Not reviewed for REACH October 2008 SvHC(s)

REACH Jan/Mar 2010 SvHC Compliance: Not reviewed for REACH Jan/Mar 2010 SvHC(s)

REACH June 2010 SvHC Compliance: Contains no REACH June 2010 SvHC(s)

REACH Dec 2010 SvHC Compliance: Contains no REACH December 2010 SvHC(s)

REACH June 2011 SvHC Compliance: Not reviewed for REACH June 2011 SvHC(s)

REACH December 2011 SvHC Compliance: Not reviewed for REACH December 2011 SvHC(s)

REACH June 2012 SvHC Compliance: Not reviewed for REACH June 2012 SvHC(s)

Halogen Content: Not Yet Reviewed for halogen content

David R. Bender

Director, Product Compliance

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The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hex chrome, mercury, PBB, PBDE, and 0.01% for cadmium, or qualify for an exemption to above limits as defined in the Annex of the EU RoHS Directive. Note that any exemptions taken in this case would not include application specific exemptions (e.g. lead in solder for servers) as TE cannot determine where component products will be used.

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05 September 2012

中国电子信息产品环境信息  
China EIP Environmental Information



Restricted Materials Above Threshold

电子元件 (Electronic Component) 1711609-3	有毒有害物质或元素 Hazardous Substance					
	铅 (Pb)	汞 (Hg)	镉 (Cd)	六价铬 (Cr6)	多溴联苯 (PBB)	多溴二苯醚 (PBDE)
电子元件 (Electronic Component)	X	○	○	○	○	○
<p>○: 表示该部件内有有毒有害物质含量在 SJ/T 11363-2006 标准规定的限量要求以下 Indicates that the concentration of the hazardous substance in the part is below the relevant threshold of the SJ/T 1136 3-2006 standard.</p> <p>X: 表示该部件内有有毒有害物质含量超出 SJ/T 11363-2006 标准规定的限量要求 Indicates that the concentration of the hazardous substance in the part is above the relevant threshold of the SJ/T 1136 3-2006 standard.</p>						

Description for part 1711609-3:

INSERT CAT7a ARJ45 style /B

The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hex chrome, mercury, PBB, PBDE, and 0.01% for cadmium, or qualify for an exemption to above limits as defined in the Annex of the EU RoHS Directive. Note that any exemptions taken in this case would not include application specific exemptions (e.g. lead in solder for servers) as TE cannot determine where component products will be used.

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## Statement of Compliance

### Requested Part

05 September 2012

1711409-5


( Part 1 of 1)

### INSERT CAT7a AMPTWIST7aS style /W

Status: Active

EU RoHS/ELV Code: 5 of 6 EU RoHS/ELV Compliant

Solder Process Capability Code: Not applicable for solder process capability

China RoHS:  Restricted Materials Above Threshold

Exemptions: 6(c) - Pb-Alloy in Copper

7(x) - Pb-Used for ELV, 5/6 parts

REACH Oct 2008 SvHC Compliance: Not reviewed for REACH October 2008 SvHC(s)

REACH Jan/Mar 2010 SvHC Compliance: Not reviewed for REACH Jan/Mar 2010 SvHC(s)

REACH June 2010 SvHC Compliance: Contains no REACH June 2010 SvHC(s)

REACH Dec 2010 SvHC Compliance: Contains no REACH December 2010 SvHC(s)

REACH June 2011 SvHC Compliance: Not reviewed for REACH June 2011 SvHC(s)

REACH December 2011 SvHC Compliance: Not reviewed for REACH December 2011 SvHC(s)

REACH June 2012 SvHC Compliance: Not reviewed for REACH June 2012 SvHC(s)

Halogen Content: Not Yet Reviewed for halogen content

David R. Bender

Director, Product Compliance

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The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hex chrome, mercury, PBB, PBDE, and 0.01% for cadmium, or qualify for an exemption to above limits as defined in the Annex of the EU RoHS Directive. Note that any exemptions taken in this case would not include application specific exemptions (e.g. lead in solder for servers) as TE cannot determine where component products will be used.

Additionally, the part numbers that are identified as 5 of 6 compliant meet the material limits described above, except that these products have lead in the solderable interface only. These products may be suitable for use in an application that has an exemption for the use of lead in solder (e.g. servers, network infrastructure, etc).

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05 September 2012

中国电子信息产品环境信息  
China EIP Environmental Information



Restricted Materials Above Threshold

电子元件 (Electronic Component) 1711409-5	有毒有害物质或元素 Hazardous Substance					
	铅 (Pb)	汞 (Hg)	镉 (Cd)	六价铬 (Cr6)	多溴联苯 (PBB)	多溴二苯醚 (PBDE)
电子元件 (Electronic Component)	X	O	O	O	O	O

O: 表示该部件内有有毒有害物质含量在 SJ/T 11363-2006 标准规定的限量要求以下  
Indicates that the concentration of the hazardous substance in the part is below the relevant threshold of the SJ/T 1136 3-2006 standard.

X: 表示该部件内有有毒有害物质含量超出 SJ/T 11363-2006 标准规定的限量要求  
Indicates that the concentration of the hazardous substance in the part is above the relevant threshold of the SJ/T 1136 3-2006 standard.

Description for part 1711409-5:

INSERT CAT7a AMPTWIST7aS style /W

The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hex chrome, mercury, PBB, PBDE, and 0.01% for cadmium, or qualify for an exemption to above limits as defined in the Annex of the EU RoHS Directive. Note that any exemptions taken in this case would not include application specific exemptions (e.g. lead in solder for servers) as TE cannot determine where component products will be used.

Additionally, the part numbers that are identified as 5 of 6 compliant meet the material limits described above, except that these products have lead in the solderable interface only. These products may be suitable for use in an application that has an exemption for the use of lead in solder (e.g. servers, network infrastructure, etc).

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## Statement of Compliance

### Requested Part

05 September 2012

1711409-3


( Part 1 of 1)

INSERT CAT7a AMPTWIST7aS style /B

Status: Active

EU RoHS/ELV Code: 5 of 6 EU RoHS/ELV Compliant

Solder Process Capability Code: Not applicable for solder process capability

China RoHS:  Restricted Materials Above Threshold

Exemptions: 6(c) - Pb-Alloy in Copper

7(x) - Pb-Used for ELV, 5/6 parts

REACH Oct 2008 SvHC Compliance: Not reviewed for REACH October 2008 SvHC(s)

REACH Jan/Mar 2010 SvHC Compliance: Not reviewed for REACH Jan/Mar 2010 SvHC(s)

REACH June 2010 SvHC Compliance: Contains no REACH June 2010 SvHC(s)

REACH Dec 2010 SvHC Compliance: Contains no REACH December 2010 SvHC(s)

REACH June 2011 SvHC Compliance: Not reviewed for REACH June 2011 SvHC(s)

REACH December 2011 SvHC Compliance: Not reviewed for REACH December 2011 SvHC(s)

REACH June 2012 SvHC Compliance: Not reviewed for REACH June 2012 SvHC(s)

Halogen Content: Not Yet Reviewed for halogen content

David R. Bender

Director, Product Compliance

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The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hex chrome, mercury, PBB, PBDE, and 0.01% for cadmium, or qualify for an exemption to above limits as defined in the Annex of the EU RoHS Directive. Note that any exemptions taken in this case would not include application specific exemptions (e.g. lead in solder for servers) as TE cannot determine where component products will be used.

Additionally, the part numbers that are identified as 5 of 6 compliant meet the material limits described above, except that these products have lead in the solderable interface only. These products may be suitable for use in an application that has an exemption for the use of lead in solder (e.g. servers, network infrastructure, etc).

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05 September 2012

中国电子信息产品环境信息  
China EIP Environmental Information



Restricted Materials Above Threshold

电子元件 (Electronic Component) 1711409-3	有毒有害物质或元素 Hazardous Substance					
	铅 (Pb)	汞 (Hg)	镉 (Cd)	六价铬 (Cr6)	多溴联苯 (PBB)	多溴二苯醚 (PBDE)
电子元件 (Electronic Component)	X	O	O	O	O	O

O: 表示该部件内有有毒有害物质含量在 SJ/T 11363-2006 标准规定的限量要求以下  
Indicates that the concentration of the hazardous substance in the part is below the relevant threshold of the SJ/T 1136 3-2006 standard.

X: 表示该部件内有有毒有害物质含量超出 SJ/T 11363-2006 标准规定的限量要求  
Indicates that the concentration of the hazardous substance in the part is above the relevant threshold of the SJ/T 1136 3-2006 standard.

Description for part 1711409-3:

INSERT CAT7a AMPTWIST7aS style /B

The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hex chrome, mercury, PBB, PBDE, and 0.01% for cadmium, or qualify for an exemption to above limits as defined in the Annex of the EU RoHS Directive. Note that any exemptions taken in this case would not include application specific exemptions (e.g. lead in solder for servers) as TE cannot determine where component products will be used.

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## Statement of Compliance

### Requested Part

05 September 2012

1711336-1


( Part 1 of 1)

INSERT MULTIMEDIA CATV&TEL&100BT /A

Status: Active

EU RoHS/ELV Code: 5 of 6 EU RoHS/ELV Compliant

Solder Process Capability Code: Not applicable for solder process capability

China RoHS:  Restricted Materials Above Threshold

Exemptions: 6(c) - Pb-Alloy in Copper

7(x) - Pb-Used for ELV, 5/6 parts

REACH Oct 2008 SvHC Compliance: Not reviewed for REACH October 2008 SvHC(s)

REACH Jan/Mar 2010 SvHC Compliance: Not reviewed for REACH Jan/Mar 2010 SvHC(s)

REACH June 2010 SvHC Compliance: Contains no REACH June 2010 SvHC(s)

REACH Dec 2010 SvHC Compliance: Contains no REACH December 2010 SvHC(s)

REACH June 2011 SvHC Compliance: Not reviewed for REACH June 2011 SvHC(s)

REACH December 2011 SvHC Compliance: Not reviewed for REACH December 2011 SvHC(s)

REACH June 2012 SvHC Compliance: Not reviewed for REACH June 2012 SvHC(s)

Halogen Content: Not Yet Reviewed for halogen content

David R. Bender

Director, Product Compliance

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The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hex chrome, mercury, PBB, PBDE, and 0.01% for cadmium, or qualify for an exemption to above limits as defined in the Annex of the EU RoHS Directive. Note that any exemptions taken in this case would not include application specific exemptions (e.g. lead in solder for servers) as TE cannot determine where component products will be used.

Additionally, the part numbers that are identified as 5 of 6 compliant meet the material limits described above, except that these products have lead in the solderable interface only. These products may be suitable for use in an application that has an exemption for the use of lead in solder (e.g. servers, network infrastructure, etc).

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information provided by our suppliers. This information is subject to change.



05 September 2012

中国电子信息产品环境信息  
China EIP Environmental Information



Restricted Materials Above Threshold

电子元件 (Electronic Component) 1711336-1	有毒有害物质或元素 Hazardous Substance					
	铅 (Pb)	汞 (Hg)	镉 (Cd)	六价铬 (Cr6)	多溴联苯 (PBB)	多溴二苯醚 (PBDE)
电子元件 (Electronic Component)	X	O	O	O	O	O
<p>O: 表示该部件内有有毒有害物质含量在 SJ/T 11363-2006 标准规定的限量要求以下 Indicates that the concentration of the hazardous substance in the part is below the relevant threshold of the SJ/T 1136 3-2006 standard.</p> <p>X: 表示该部件内有有毒有害物质含量超出 SJ/T 11363-2006 标准规定的限量要求 Indicates that the concentration of the hazardous substance in the part is above the relevant threshold of the SJ/T 1136 3-2006 standard.</p>						

Description for part 1711336-1:

INSERT MULTIMEDIA CATV&TEL&100BT /A

The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hex chrome, mercury, PBB, PBDE, and 0.01% for cadmium, or qualify for an exemption to above limits as defined in the Annex of the EU RoHS Directive. Note that any exemptions taken in this case would not include application specific exemptions (e.g. lead in solder for servers) as TE cannot determine where component products will be used.

Additionally, the part numbers that are identified as 5 of 6 compliant meet the material limits described above, except that these products have lead in the solderable interface only. These products may be suitable for use in an application that has an exemption for the use of lead in solder (e.g. servers, network infrastructure, etc).

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information provided by our suppliers. This information is subject to change.



## Statement of Compliance

### Requested Part

05 September 2012

1711336-3

( Part 1 of 1)

### INSERT MULTIMEDIA CATV&TEL&100BT /B

Status: Active

EU RoHS/ELV Code: 5 of 6 EU RoHS/ELV Compliant

Solder Process Capability Code: Not applicable for solder process capability

China RoHS:  Restricted Materials Above Threshold

Exemptions: 6(c) - Pb-Alloy in Copper

7(x) - Pb-Used for ELV, 5/6 parts

REACH Oct 2008 SvHC Compliance: Not reviewed for REACH October 2008 SvHC(s)

REACH Jan/Mar 2010 SvHC Compliance: Not reviewed for REACH Jan/Mar 2010 SvHC(s)

REACH June 2010 SvHC Compliance: Contains no REACH June 2010 SvHC(s)

REACH Dec 2010 SvHC Compliance: Contains no REACH December 2010 SvHC(s)

REACH June 2011 SvHC Compliance: Not reviewed for REACH June 2011 SvHC(s)

REACH December 2011 SvHC Compliance: Not reviewed for REACH December 2011 SvHC(s)

REACH June 2012 SvHC Compliance: Not reviewed for REACH June 2012 SvHC(s)

Halogen Content: Not Yet Reviewed for halogen content

David R. Bender

Director, Product Compliance

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The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hex chrome, mercury, PBB, PBDE, and 0.01% for cadmium, or qualify for an exemption to above limits as defined in the Annex of the EU RoHS Directive. Note that any exemptions taken in this case would not include application specific exemptions (e.g. lead in solder for servers) as TE cannot determine where component products will be used.

Additionally, the part numbers that are identified as 5 of 6 compliant meet the material limits described above, except that these products have lead in the solderable interface only. These products may be suitable for use in an application that has an exemption for the use of lead in solder (e.g. servers, network infrastructure, etc).

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05 September 2012

中国电子信息产品环境信息  
China EIP Environmental Information



Restricted Materials Above Threshold

电子元件 (Electronic Component) 1711336-3	有毒有害物质或元素 Hazardous Substance					
	铅 (Pb)	汞 (Hg)	镉 (Cd)	六价铬 (Cr6)	多溴联苯 (PBB)	多溴二苯醚 (PBDE)
电子元件 (Electronic Component)	X	O	O	O	O	O

O: 表示该部件内有有毒有害物质含量在 SJ/T 11363-2006 标准规定的限量要求以下  
Indicates that the concentration of the hazardous substance in the part is below the relevant threshold of the SJ/T 1136 3-2006 standard.

X: 表示该部件内有有毒有害物质含量超出 SJ/T 11363-2006 标准规定的限量要求  
Indicates that the concentration of the hazardous substance in the part is above the relevant threshold of the SJ/T 1136 3-2006 standard.

Description for part 1711336-3:

INSERT MULTIMEDIA CATV&TEL&100BT /B

The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hex chrome, mercury, PBB, PBDE, and 0.01% for cadmium, or qualify for an exemption to above limits as defined in the Annex of the EU RoHS Directive. Note that any exemptions taken in this case would not include application specific exemptions (e.g. lead in solder for servers) as TE cannot determine where component products will be used.

Additionally, the part numbers that are identified as 5 of 6 compliant meet the material limits described above, except that these products have lead in the solderable interface only. These products may be suitable for use in an application that has an exemption for the use of lead in solder (e.g. servers, network infrastructure, etc).

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information provided by our suppliers. This information is subject to change.



## Statement of Compliance

### Requested Part

05 September 2012

1711130-5

( Part 1 of 1)

INSERT ISDN & PoE B->A for PP /W

Status: Active

EU RoHS/ELV Code: 5 of 6 EU RoHS/ELV Compliant

Solder Process Capability Code: Not applicable for solder process capability

China RoHS:  Restricted Materials Above Threshold

Exemptions: 7(a) - Pb-High melt temp. solder

7(x) - Pb-Used for ELV, 5/6 parts

REACH Oct 2008 SvHC Compliance: Not reviewed for REACH October 2008 SvHC(s)

REACH Jan/Mar 2010 SvHC Compliance: Not reviewed for REACH Jan/Mar 2010 SvHC(s)

REACH June 2010 SvHC Compliance: Contains no REACH June 2010 SvHC(s)

REACH Dec 2010 SvHC Compliance: Contains no REACH December 2010 SvHC(s)

REACH June 2011 SvHC Compliance: Not reviewed for REACH June 2011 SvHC(s)

REACH December 2011 SvHC Compliance: Not reviewed for REACH December 2011 SvHC(s)

REACH June 2012 SvHC Compliance: Not reviewed for REACH June 2012 SvHC(s)

Halogen Content: Not Yet Reviewed for halogen content

David R. Bender

Director, Product Compliance

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The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hex chrome, mercury, PBB, PBDE, and 0.01% for cadmium, or qualify for an exemption to above limits as defined in the Annex of the EU RoHS Directive. Note that any exemptions taken in this case would not include application specific exemptions (e.g. lead in solder for servers) as TE cannot determine where component products will be used.

Additionally, the part numbers that are identified as 5 of 6 compliant meet the material limits described above, except that these products have lead in the solderable interface only. These products may be suitable for use in an application that has an exemption for the use of lead in solder (e.g. servers, network infrastructure, etc).

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information provided by our suppliers. This information is subject to change.



05 September 2012

中国电子信息产品环境信息  
China EIP Environmental Information



Restricted Materials Above Threshold

电子元件 (Electronic Component) 1711130-5	有毒有害物质或元素 Hazardous Substance					
	铅 (Pb)	汞 (Hg)	镉 (Cd)	六价铬 (Cr6)	多溴联苯 (PBB)	多溴二苯醚 (PBDE)
电子元件 (Electronic Component)	X	O	O	O	O	O
<p>O: 表示该部件内有有毒有害物质含量在 SJ/T 11363-2006 标准规定的限量要求以下 Indicates that the concentration of the hazardous substance in the part is below the relevant threshold of the SJ/T 1136 3-2006 standard.</p> <p>X: 表示该部件内有有毒有害物质含量超出 SJ/T 11363-2006 标准规定的限量要求 Indicates that the concentration of the hazardous substance in the part is above the relevant threshold of the SJ/T 1136 3-2006 standard.</p>						

Description for part 1711130-5:

INSERT ISDN & PoE B->A for PP /W

The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hex chrome, mercury, PBB, PBDE, and 0.01% for cadmium, or qualify for an exemption to above limits as defined in the Annex of the EU RoHS Directive. Note that any exemptions taken in this case would not include application specific exemptions (e.g. lead in solder for servers) as TE cannot determine where component products will be used.

Additionally, the part numbers that are identified as 5 of 6 compliant meet the material limits described above, except that these products have lead in the solderable interface only. These products may be suitable for use in an application that has an exemption for the use of lead in solder (e.g. servers, network infrastructure, etc).

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## Statement of Compliance

### Requested Part

05 September 2012

1711130-1


( Part 1 of 1)

### INSERT ISDN & PoE B->A for PP /A

Status: Active

EU RoHS/ELV Code: 5 of 6 EU RoHS/ELV Compliant

Solder Process Capability Code: Not applicable for solder process capability

China RoHS:  Restricted Materials Above Threshold

Exemptions: 7(a) - Pb-High melt temp. solder

7(x) - Pb-Used for ELV, 5/6 parts

REACH Oct 2008 SvHC Compliance: Not reviewed for REACH October 2008 SvHC(s)

REACH Jan/Mar 2010 SvHC Compliance: Not reviewed for REACH Jan/Mar 2010 SvHC(s)

REACH June 2010 SvHC Compliance: Contains no REACH June 2010 SvHC(s)

REACH Dec 2010 SvHC Compliance: Contains no REACH December 2010 SvHC(s)

REACH June 2011 SvHC Compliance: Not reviewed for REACH June 2011 SvHC(s)

REACH December 2011 SvHC Compliance: Not reviewed for REACH December 2011 SvHC(s)

REACH June 2012 SvHC Compliance: Not reviewed for REACH June 2012 SvHC(s)

Halogen Content: Not Yet Reviewed for halogen content

David R. Bender

Director, Product Compliance

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The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hex chrome, mercury, PBB, PBDE, and 0.01% for cadmium, or qualify for an exemption to above limits as defined in the Annex of the EU RoHS Directive. Note that any exemptions taken in this case would not include application specific exemptions (e.g. lead in solder for servers) as TE cannot determine where component products will be used.

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05 September 2012

中国电子信息产品环境信息  
China EIP Environmental Information



Restricted Materials Above Threshold

电子元件 (Electronic Component) 1711130-1	有毒有害物质或元素 Hazardous Substance					
	铅 (Pb)	汞 (Hg)	镉 (Cd)	六价铬 (Cr6)	多溴联苯 (PBB)	多溴二苯醚 (PBDE)
电子元件 (Electronic Component)	X	O	O	O	O	O

O: 表示该部件内有有毒有害物质含量在 SJ/T 11363-2006 标准规定的限量要求以下  
Indicates that the concentration of the hazardous substance in the part is below the relevant threshold of the SJ/T 1136 3-2006 standard.

X: 表示该部件内有有毒有害物质含量超出 SJ/T 11363-2006 标准规定的限量要求  
Indicates that the concentration of the hazardous substance in the part is above the relevant threshold of the SJ/T 1136 3-2006 standard.

Description for part 1711130-1:

INSERT ISDN & PoE B->A for PP /A

The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hex chrome, mercury, PBB, PBDE, and 0.01% for cadmium, or qualify for an exemption to above limits as defined in the Annex of the EU RoHS Directive. Note that any exemptions taken in this case would not include application specific exemptions (e.g. lead in solder for servers) as TE cannot determine where component products will be used.

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## Statement of Compliance

### Requested Part

05 September 2012

1711130-3


( Part 1 of 1)

### INSERT ISDN & PoE B->A for PP /B

Status: Active

EU RoHS/ELV Code: 5 of 6 EU RoHS/ELV Compliant

Solder Process Capability Code: Not applicable for solder process capability

China RoHS:  Restricted Materials Above Threshold

Exemptions: 7(a) - Pb-High melt temp. solder

7(x) - Pb-Used for ELV, 5/6 parts

REACH Oct 2008 SvHC Compliance: Not reviewed for REACH October 2008 SvHC(s)

REACH Jan/Mar 2010 SvHC Compliance: Not reviewed for REACH Jan/Mar 2010 SvHC(s)

REACH June 2010 SvHC Compliance: Contains no REACH June 2010 SvHC(s)

REACH Dec 2010 SvHC Compliance: Contains no REACH December 2010 SvHC(s)

REACH June 2011 SvHC Compliance: Not reviewed for REACH June 2011 SvHC(s)

REACH December 2011 SvHC Compliance: Not reviewed for REACH December 2011 SvHC(s)

REACH June 2012 SvHC Compliance: Not reviewed for REACH June 2012 SvHC(s)

Halogen Content: Not Yet Reviewed for halogen content



David R. Bender

Director, Product Compliance

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The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hex chrome, mercury, PBB, PBDE, and 0.01% for cadmium, or qualify for an exemption to above limits as defined in the Annex of the EU RoHS Directive. Note that any exemptions taken in this case would not include application specific exemptions (e.g. lead in solder for servers) as TE cannot determine where component products will be used.

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05 September 2012

中国电子信息产品环境信息  
China EIP Environmental Information



Restricted Materials Above Threshold

电子元件 (Electronic Component) 1711130-3	有毒有害物质或元素 Hazardous Substance					
	铅 (Pb)	汞 (Hg)	镉 (Cd)	六价铬 (Cr6)	多溴联苯 (PBB)	多溴二苯醚 (PBDE)
电子元件 (Electronic Component)	X	O	O	O	O	O

O: 表示该部件内有有毒有害物质含量在 SJ/T 11363-2006 标准规定的限量要求以下  
Indicates that the concentration of the hazardous substance in the part is below the relevant threshold of the SJ/T 1136 3-2006 standard.

X: 表示该部件内有有毒有害物质含量超出 SJ/T 11363-2006 标准规定的限量要求  
Indicates that the concentration of the hazardous substance in the part is above the relevant threshold of the SJ/T 1136 3-2006 standard.

Description for part 1711130-3:

INSERT ISDN & PoE B->A for PP /B

The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hex chrome, mercury, PBB, PBDE, and 0.01% for cadmium, or qualify for an exemption to above limits as defined in the Annex of the EU RoHS Directive. Note that any exemptions taken in this case would not include application specific exemptions (e.g. lead in solder for servers) as TE cannot determine where component products will be used.

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## Statement of Compliance

### Requested Part

05 September 2012

1711140-1

( Part 1 of 1)

### INSERT ISDN & PoE mode A /A

Status: Active

EU RoHS/ELV Code: 5 of 6 EU RoHS/ELV Compliant

Solder Process Capability Code: Not applicable for solder process capability

China RoHS:  Restricted Materials Above Threshold

Exemptions: 7(x) - Pb-Used for ELV, 5/6 parts

REACH Oct 2008 SvHC Compliance: Not reviewed for REACH October 2008 SvHC(s)

REACH Jan/Mar 2010 SvHC Compliance: Not reviewed for REACH Jan/Mar 2010 SvHC(s)

REACH June 2010 SvHC Compliance: Contains no REACH June 2010 SvHC(s)

REACH Dec 2010 SvHC Compliance: Contains no REACH December 2010 SvHC(s)

REACH June 2011 SvHC Compliance: Not reviewed for REACH June 2011 SvHC(s)

REACH December 2011 SvHC Compliance: Not reviewed for REACH December 2011 SvHC(s)

REACH June 2012 SvHC Compliance: Not reviewed for REACH June 2012 SvHC(s)

Halogen Content: Not Yet Reviewed for halogen content

David R. Bender

Director, Product Compliance

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The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hex chrome, mercury, PBB, PBDE, and 0.01% for cadmium, or qualify for an exemption to above limits as defined in the Annex of the EU RoHS Directive. Note that any exemptions taken in this case would not include application specific exemptions (e.g. lead in solder for servers) as TE cannot determine where component products will be used.

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05 September 2012

中国电子信息产品环境信息  
China EIP Environmental Information



Restricted Materials Above Threshold

电子元件 (Electronic Component) 1711140-1	有毒有害物质或元素 Hazardous Substance					
	铅 (Pb)	汞 (Hg)	镉 (Cd)	六价铬 (Cr6)	多溴联苯 (PBB)	多溴二苯醚 (PBDE)
电子元件 (Electronic Component)	X	O	O	O	O	O

O: 表示该部件内有有毒有害物质含量在 SJ/T 11363-2006 标准规定的限量要求以下  
Indicates that the concentration of the hazardous substance in the part is below the relevant threshold of the SJ/T 1136 3-2006 standard.

X: 表示该部件内有有毒有害物质含量超出 SJ/T 11363-2006 标准规定的限量要求  
Indicates that the concentration of the hazardous substance in the part is above the relevant threshold of the SJ/T 1136 3-2006 standard.

Description for part 1711140-1:

INSERT ISDN & PoE mode A /A

The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hex chrome, mercury, PBB, PBDE, and 0.01% for cadmium, or qualify for an exemption to above limits as defined in the Annex of the EU RoHS Directive. Note that any exemptions taken in this case would not include application specific exemptions (e.g. lead in solder for servers) as TE cannot determine where component products will be used.

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## Statement of Compliance

### Requested Part

05 September 2012

1711140-3

( Part 1 of 1)

### INSERT ISDN & PoE mode A /B

Status: Active

EU RoHS/ELV Code: 5 of 6 EU RoHS/ELV Compliant

Solder Process Capability Code: Not applicable for solder process capability

China RoHS:  Restricted Materials Above Threshold

Exemptions: 7(x) - Pb-Used for ELV, 5/6 parts

REACH Oct 2008 SvHC Compliance: Not reviewed for REACH October 2008 SvHC(s)

REACH Jan/Mar 2010 SvHC Compliance: Not reviewed for REACH Jan/Mar 2010 SvHC(s)

REACH June 2010 SvHC Compliance: Contains no REACH June 2010 SvHC(s)

REACH Dec 2010 SvHC Compliance: Contains no REACH December 2010 SvHC(s)

REACH June 2011 SvHC Compliance: Not reviewed for REACH June 2011 SvHC(s)

REACH December 2011 SvHC Compliance: Not reviewed for REACH December 2011 SvHC(s)

REACH June 2012 SvHC Compliance: Not reviewed for REACH June 2012 SvHC(s)

Halogen Content: Not Yet Reviewed for halogen content

David R. Bender

Director, Product Compliance

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The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hex chrome, mercury, PBB, PBDE, and 0.01% for cadmium, or qualify for an exemption to above limits as defined in the Annex of the EU RoHS Directive. Note that any exemptions taken in this case would not include application specific exemptions (e.g. lead in solder for servers) as TE cannot determine where component products will be used.

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05 September 2012

中国电子信息产品环境信息  
China EIP Environmental Information



Restricted Materials Above Threshold

电子元件 (Electronic Component) 1711140-3	有毒有害物质或元素 Hazardous Substance					
	铅 (Pb)	汞 (Hg)	镉 (Cd)	六价铬 (Cr6)	多溴联苯 (PBB)	多溴二苯醚 (PBDE)
电子元件 (Electronic Component)	X	O	O	O	O	O
<p>O: 表示该部件内有有毒有害物质含量在 SJ/T 11363-2006 标准规定的限量要求以下 Indicates that the concentration of the hazardous substance in the part is below the relevant threshold of the SJ/T 1136 3-2006 standard.</p> <p>X: 表示该部件内有有毒有害物质含量超出 SJ/T 11363-2006 标准规定的限量要求 Indicates that the concentration of the hazardous substance in the part is above the relevant threshold of the SJ/T 1136 3-2006 standard.</p>						

Description for part 1711140-3:

INSERT ISDN & PoE mode A /B

The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hex chrome, mercury, PBB, PBDE, and 0.01% for cadmium, or qualify for an exemption to above limits as defined in the Annex of the EU RoHS Directive. Note that any exemptions taken in this case would not include application specific exemptions (e.g. lead in solder for servers) as TE cannot determine where component products will be used.

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## Statement of Compliance

### Requested Part

05 September 2012

1711336-5


( Part 1 of 1)

### INSERT MULTIMEDIA CATV&TEL&100BT /W

Status: Active

EU RoHS/ELV Code: 5 of 6 EU RoHS/ELV Compliant

Solder Process Capability Code: Not applicable for solder process capability

China RoHS:  Restricted Materials Above Threshold

Exemptions: 6(c) - Pb-Alloy in Copper

7(x) - Pb-Used for ELV, 5/6 parts

REACH Oct 2008 SvHC Compliance: Not reviewed for REACH October 2008 SvHC(s)

REACH Jan/Mar 2010 SvHC Compliance: Not reviewed for REACH Jan/Mar 2010 SvHC(s)

REACH June 2010 SvHC Compliance: Contains no REACH June 2010 SvHC(s)

REACH Dec 2010 SvHC Compliance: Contains no REACH December 2010 SvHC(s)

REACH June 2011 SvHC Compliance: Not reviewed for REACH June 2011 SvHC(s)

REACH December 2011 SvHC Compliance: Not reviewed for REACH December 2011 SvHC(s)

REACH June 2012 SvHC Compliance: Not reviewed for REACH June 2012 SvHC(s)

Halogen Content: Not Yet Reviewed for halogen content

David R. Bender

Director, Product Compliance

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The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hex chrome, mercury, PBB, PBDE, and 0.01% for cadmium, or qualify for an exemption to above limits as defined in the Annex of the EU RoHS Directive. Note that any exemptions taken in this case would not include application specific exemptions (e.g. lead in solder for servers) as TE cannot determine where component products will be used.

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05 September 2012

中国电子信息产品环境信息  
China EIP Environmental Information



Restricted Materials Above Threshold

电子元件 (Electronic Component) 1711336-5	有毒有害物质或元素 Hazardous Substance					
	铅 (Pb)	汞 (Hg)	镉 (Cd)	六价铬 (Cr6)	多溴联苯 (PBB)	多溴二苯醚 (PBDE)
电子元件 (Electronic Component)	X	O	O	O	O	O

O: 表示该部件内有有毒有害物质含量在 SJ/T 11363-2006 标准规定的限量要求以下  
Indicates that the concentration of the hazardous substance in the part is below the relevant threshold of the SJ/T 1136 3-2006 standard.

X: 表示该部件内有有毒有害物质含量超出 SJ/T 11363-2006 标准规定的限量要求  
Indicates that the concentration of the hazardous substance in the part is above the relevant threshold of the SJ/T 1136 3-2006 standard.

Description for part 1711336-5:

INSERT MULTIMEDIA CATV&TEL&100BT /W

The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hex chrome, mercury, PBB, PBDE, and 0.01% for cadmium, or qualify for an exemption to above limits as defined in the Annex of the EU RoHS Directive. Note that any exemptions taken in this case would not include application specific exemptions (e.g. lead in solder for servers) as TE cannot determine where component products will be used.

Additionally, the part numbers that are identified as 5 of 6 compliant meet the material limits described above, except that these products have lead in the solderable interface only. These products may be suitable for use in an application that has an exemption for the use of lead in solder (e.g. servers, network infrastructure, etc).

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## Statement of Compliance

### Requested Part

05 September 2012

1711125-5

( Part 1 of 1)

INSERT dual PoE B->A for PP IW

Status: Active

EU RoHS/ELV Code: 5 of 6 EU RoHS/ELV Compliant

Solder Process Capability Code: Not applicable for solder process capability

China RoHS:  Restricted Materials Above Threshold

Exemptions: 7(a) - Pb-High melt temp. solder

7(x) - Pb-Used for ELV, 5/6 parts

REACH Oct 2008 SvHC Compliance: Not reviewed for REACH October 2008 SvHC(s)

REACH Jan/Mar 2010 SvHC Compliance: Not reviewed for REACH Jan/Mar 2010 SvHC(s)

REACH June 2010 SvHC Compliance: Contains no REACH June 2010 SvHC(s)

REACH Dec 2010 SvHC Compliance: Contains no REACH December 2010 SvHC(s)

REACH June 2011 SvHC Compliance: Not reviewed for REACH June 2011 SvHC(s)

REACH December 2011 SvHC Compliance: Not reviewed for REACH December 2011 SvHC(s)

REACH June 2012 SvHC Compliance: Not reviewed for REACH June 2012 SvHC(s)

Halogen Content: Not Yet Reviewed for halogen content

David R. Bender

Director, Product Compliance

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The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hex chrome, mercury, PBB, PBDE, and 0.01% for cadmium, or qualify for an exemption to above limits as defined in the Annex of the EU RoHS Directive. Note that any exemptions taken in this case would not include application specific exemptions (e.g. lead in solder for servers) as TE cannot determine where component products will be used.

Additionally, the part numbers that are identified as 5 of 6 compliant meet the material limits described above, except that these products have lead in the solderable interface only. These products may be suitable for use in an application that has an exemption for the use of lead in solder (e.g. servers, network infrastructure, etc).

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05 September 2012

中国电子信息产品环境信息  
China EIP Environmental Information



Restricted Materials Above Threshold

电子元件 (Electronic Component) 1711125-5	有毒有害物质或元素 Hazardous Substance					
	铅 (Pb)	汞 (Hg)	镉 (Cd)	六价铬 (Cr6)	多溴联苯 (PBB)	多溴二苯醚 (PBDE)
电子元件 (Electronic Component)	X	○	○	○	○	○
<p>O: 表示该部件内有有毒有害物质含量在 SJ/T 11363-2006 标准规定的限量要求以下 Indicates that the concentration of the hazardous substance in the part is below the relevant threshold of the SJ/T 1136 3-2006 standard.</p> <p>X: 表示该部件内有有毒有害物质含量超出 SJ/T 11363-2006 标准规定的限量要求 Indicates that the concentration of the hazardous substance in the part is above the relevant threshold of the SJ/T 1136 3-2006 standard.</p>						

Description for part 1711125-5:

INSERT dual PoE B->A for PP /W

The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hex chrome, mercury, PBB, PBDE, and 0.01% for cadmium, or qualify for an exemption to above limits as defined in the Annex of the EU RoHS Directive. Note that any exemptions taken in this case would not include application specific exemptions (e.g. lead in solder for servers) as TE cannot determine where component products will be used.

Additionally, the part numbers that are identified as 5 of 6 compliant meet the material limits described above, except that these products have lead in the solderable interface only. These products may be suitable for use in an application that has an exemption for the use of lead in solder (e.g. servers, network infrastructure, etc).

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## Statement of Compliance

### Requested Part

05 September 2012

1711125-1

( Part 1 of 1)

INSERT dual PoE B->A for PP /A

Status: Active

EU RoHS/ELV Code: 5 of 6 EU RoHS/ELV Compliant

Solder Process Capability Code: Not applicable for solder process capability

China RoHS:  Restricted Materials Above Threshold

Exemptions: 7(a) - Pb-High melt temp. solder

7(x) - Pb-Used for ELV, 5/6 parts

REACH Oct 2008 SvHC Compliance: Not reviewed for REACH October 2008 SvHC(s)

REACH Jan/Mar 2010 SvHC Compliance: Not reviewed for REACH Jan/Mar 2010 SvHC(s)

REACH June 2010 SvHC Compliance: Contains no REACH June 2010 SvHC(s)

REACH Dec 2010 SvHC Compliance: Contains no REACH December 2010 SvHC(s)

REACH June 2011 SvHC Compliance: Not reviewed for REACH June 2011 SvHC(s)

REACH December 2011 SvHC Compliance: Not reviewed for REACH December 2011 SvHC(s)

REACH June 2012 SvHC Compliance: Not reviewed for REACH June 2012 SvHC(s)

Halogen Content: Not Yet Reviewed for halogen content

David R. Bender

Director, Product Compliance

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The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hex chrome, mercury, PBB, PBDE, and 0.01% for cadmium, or qualify for an exemption to above limits as defined in the Annex of the EU RoHS Directive. Note that any exemptions taken in this case would not include application specific exemptions (e.g. lead in solder for servers) as TE cannot determine where component products will be used.

Additionally, the part numbers that are identified as 5 of 6 compliant meet the material limits described above, except that these products have lead in the solderable interface only. These products may be suitable for use in an application that has an exemption for the use of lead in solder (e.g. servers, network infrastructure, etc).

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05 September 2012

中国电子信息产品环境信息  
China EIP Environmental Information



Restricted Materials Above Threshold

电子元件 (Electronic Component) 1711125-1	有毒有害物质或元素 Hazardous Substance					
	铅 (Pb)	汞 (Hg)	镉 (Cd)	六价铬 (Cr6)	多溴联苯 (PBB)	多溴二苯醚 (PBDE)
电子元件 (Electronic Component)	X	O	O	O	O	O

O: 表示该部件内有有毒有害物质含量在 SJ/T 11363-2006 标准规定的限量要求以下  
Indicates that the concentration of the hazardous substance in the part is below the relevant threshold of the SJ/T 1136 3-2006 standard.

X: 表示该部件内有有毒有害物质含量超出 SJ/T 11363-2006 标准规定的限量要求  
Indicates that the concentration of the hazardous substance in the part is above the relevant threshold of the SJ/T 1136 3-2006 standard.

Description for part 1711125-1:

INSERT dual PoE B->A for PP /A

The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hex chrome, mercury, PBB, PBDE, and 0.01% for cadmium, or qualify for an exemption to above limits as defined in the Annex of the EU RoHS Directive. Note that any exemptions taken in this case would not include application specific exemptions (e.g. lead in solder for servers) as TE cannot determine where component products will be used.

Additionally, the part numbers that are identified as 5 of 6 compliant meet the material limits described above, except that these products have lead in the solderable interface only. These products may be suitable for use in an application that has an exemption for the use of lead in solder (e.g. servers, network infrastructure, etc).

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## Statement of Compliance

### Requested Part

05 September 2012

1711125-3

( Part 1 of 1)

INSERT dual PoE B->A for PP /B

Status: Active

EU RoHS/ELV Code: 5 of 6 EU RoHS/ELV Compliant

Solder Process Capability Code: Not applicable for solder process capability

China RoHS:  Restricted Materials Above Threshold

Exemptions: 7(a) - Pb-High melt temp. solder

7(x) - Pb-Used for ELV, 5/6 parts

REACH Oct 2008 SvHC Compliance: Not reviewed for REACH October 2008 SvHC(s)

REACH Jan/Mar 2010 SvHC Compliance: Not reviewed for REACH Jan/Mar 2010 SvHC(s)

REACH June 2010 SvHC Compliance: Contains no REACH June 2010 SvHC(s)

REACH Dec 2010 SvHC Compliance: Contains no REACH December 2010 SvHC(s)

REACH June 2011 SvHC Compliance: Not reviewed for REACH June 2011 SvHC(s)

REACH December 2011 SvHC Compliance: Not reviewed for REACH December 2011 SvHC(s)

REACH June 2012 SvHC Compliance: Not reviewed for REACH June 2012 SvHC(s)

Halogen Content: Not Yet Reviewed for halogen content

David R. Bender

Director, Product Compliance

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The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hex chrome, mercury, PBB, PBDE, and 0.01% for cadmium, or qualify for an exemption to above limits as defined in the Annex of the EU RoHS Directive. Note that any exemptions taken in this case would not include application specific exemptions (e.g. lead in solder for servers) as TE cannot determine where component products will be used.

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05 September 2012

中国电子信息产品环境信息  
China EIP Environmental Information



Restricted Materials Above Threshold

电子元件 (Electronic Component) 1711125-3	有毒有害物质或元素 Hazardous Substance					
	铅 (Pb)	汞 (Hg)	镉 (Cd)	六价铬 (Cr6)	多溴联苯 (PBB)	多溴二苯醚 (PBDE)
电子元件 (Electronic Component)	X	O	O	O	O	O
<p>O: 表示该部件内有有毒有害物质含量在 SJ/T 11363-2006 标准规定的限量要求以下 Indicates that the concentration of the hazardous substance in the part is below the relevant threshold of the SJ/T 1136 3-2006 standard.</p> <p>X: 表示该部件内有有毒有害物质含量超出 SJ/T 11363-2006 标准规定的限量要求 Indicates that the concentration of the hazardous substance in the part is above the relevant threshold of the SJ/T 1136 3-2006 standard.</p>						

Description for part 1711125-3:

INSERT dual PoE B->A for PP /B

The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hex chrome, mercury, PBB, PBDE, and 0.01% for cadmium, or qualify for an exemption to above limits as defined in the Annex of the EU RoHS Directive. Note that any exemptions taken in this case would not include application specific exemptions (e.g. lead in solder for servers) as TE cannot determine where component products will be used.

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## Statement of Compliance

### Requested Part

05 September 2012

1711000-5


( Part 1 of 1)

INSERT 4x RJ45 TEL /W

Status: Active

EU RoHS/ELV Code: 5 of 6 EU RoHS/ELV Compliant

Solder Process Capability Code: Not applicable for solder process capability

China RoHS:  Restricted Materials Above Threshold

Exemptions: 7(x) - Pb-Used for ELV, 5/6 parts

REACH Oct 2008 SvHC Compliance: Not reviewed for REACH October 2008 SvHC(s)

REACH Jan/Mar 2010 SvHC Compliance: Not reviewed for REACH Jan/Mar 2010 SvHC(s)

REACH June 2010 SvHC Compliance: Contains no REACH June 2010 SvHC(s)

REACH Dec 2010 SvHC Compliance: Contains no REACH December 2010 SvHC(s)

REACH June 2011 SvHC Compliance: Not reviewed for REACH June 2011 SvHC(s)

REACH December 2011 SvHC Compliance: Not reviewed for REACH December 2011 SvHC(s)

REACH June 2012 SvHC Compliance: Not reviewed for REACH June 2012 SvHC(s)

Halogen Content: Not Yet Reviewed for halogen content

David R. Bender

Director, Product Compliance

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The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hex chrome, mercury, PBB, PBDE, and 0.01% for cadmium, or qualify for an exemption to above limits as defined in the Annex of the EU RoHS Directive. Note that any exemptions taken in this case would not include application specific exemptions (e.g. lead in solder for servers) as TE cannot determine where component products will be used.

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05 September 2012

中国电子信息产品环境信息  
China EIP Environmental Information



Restricted Materials Above Threshold

电子元件 (Electronic Component) 1711000-5	有毒有害物质或元素 Hazardous Substance					
	铅 (Pb)	汞 (Hg)	镉 (Cd)	六价铬 (Cr6)	多溴联苯 (PBB)	多溴二苯醚 (PBDE)
电子元件 (Electronic Component)	X	O	O	O	O	O

O: 表示该部件内有有毒有害物质含量在 SJ/T 11363-2006 标准规定的限量要求以下  
Indicates that the concentration of the hazardous substance in the part is below the relevant threshold of the SJ/T 1136 3-2006 standard.

X: 表示该部件内有有毒有害物质含量超出 SJ/T 11363-2006 标准规定的限量要求  
Indicates that the concentration of the hazardous substance in the part is above the relevant threshold of the SJ/T 1136 3-2006 standard.

Description for part 1711000-5:

INSERT 4x RJ45 TEL /W

The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hex chrome, mercury, PBB, PBDE, and 0.01% for cadmium, or qualify for an exemption to above limits as defined in the Annex of the EU RoHS Directive. Note that any exemptions taken in this case would not include application specific exemptions (e.g. lead in solder for servers) as TE cannot determine where component products will be used.

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## Statement of Compliance

### Requested Part

05 September 2012

1711000-1

( Part 1 of 1)

INSERT 4x RJ45 TEL /A

Status: Active

EU RoHS/ELV Code: 5 of 6 EU RoHS/ELV Compliant

Solder Process Capability Code: Not applicable for solder process capability

China RoHS:  Restricted Materials Above Threshold

Exemptions: 7(x) - Pb-Used for ELV, 5/6 parts

REACH Oct 2008 SvHC Compliance: Not reviewed for REACH October 2008 SvHC(s)

REACH Jan/Mar 2010 SvHC Compliance: Not reviewed for REACH Jan/Mar 2010 SvHC(s)

REACH June 2010 SvHC Compliance: Contains no REACH June 2010 SvHC(s)

REACH Dec 2010 SvHC Compliance: Contains no REACH December 2010 SvHC(s)

REACH June 2011 SvHC Compliance: Not reviewed for REACH June 2011 SvHC(s)

REACH December 2011 SvHC Compliance: Not reviewed for REACH December 2011 SvHC(s)

REACH June 2012 SvHC Compliance: Not reviewed for REACH June 2012 SvHC(s)

Halogen Content: Not Yet Reviewed for halogen content

David R. Bender

Director, Product Compliance

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The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hex chrome, mercury, PBB, PBDE, and 0.01% for cadmium, or qualify for an exemption to above limits as defined in the Annex of the EU RoHS Directive. Note that any exemptions taken in this case would not include application specific exemptions (e.g. lead in solder for servers) as TE cannot determine where component products will be used.

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05 September 2012

中国电子信息产品环境信息  
China EIP Environmental Information



Restricted Materials Above Threshold

电子元件 (Electronic Component) 1711000-1	有毒有害物质或元素 Hazardous Substance					
	铅 (Pb)	汞 (Hg)	镉 (Cd)	六价铬 (Cr6)	多溴联苯 (PBB)	多溴二苯醚 (PBDE)
电子元件 (Electronic Component)	X	O	O	O	O	O

O: 表示该部件内有有毒有害物质含量在 SJ/T 11363-2006 标准规定的限量要求以下  
Indicates that the concentration of the hazardous substance in the part is below the relevant threshold of the SJ/T 1136 3-2006 standard.

X: 表示该部件内有有毒有害物质含量超出 SJ/T 11363-2006 标准规定的限量要求  
Indicates that the concentration of the hazardous substance in the part is above the relevant threshold of the SJ/T 1136 3-2006 standard.

Description for part 1711000-1:

INSERT 4x RJ45 TEL /A

The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hex chrome, mercury, PBB, PBDE, and 0.01% for cadmium, or qualify for an exemption to above limits as defined in the Annex of the EU RoHS Directive. Note that any exemptions taken in this case would not include application specific exemptions (e.g. lead in solder for servers) as TE cannot determine where component products will be used.

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## Statement of Compliance

### Requested Part

05 September 2012

1711000-3

( Part 1 of 1)

INSERT 4x RJ45 TEL /B

Status: Active

EU RoHS/ELV Code: 5 of 6 EU RoHS/ELV Compliant

Solder Process Capability Code: Not applicable for solder process capability

China RoHS:  Restricted Materials Above Threshold

Exemptions: 7(x) - Pb-Used for ELV, 5/6 parts

REACH Oct 2008 SvHC Compliance: Not reviewed for REACH October 2008 SvHC(s)

REACH Jan/Mar 2010 SvHC Compliance: Not reviewed for REACH Jan/Mar 2010 SvHC(s)

REACH June 2010 SvHC Compliance: Contains no REACH June 2010 SvHC(s)

REACH Dec 2010 SvHC Compliance: Contains no REACH December 2010 SvHC(s)

REACH June 2011 SvHC Compliance: Not reviewed for REACH June 2011 SvHC(s)

REACH December 2011 SvHC Compliance: Not reviewed for REACH December 2011 SvHC(s)

REACH June 2012 SvHC Compliance: Not reviewed for REACH June 2012 SvHC(s)

Halogen Content: Not Yet Reviewed for halogen content

David R. Bender

Director, Product Compliance

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The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hex chrome, mercury, PBB, PBDE, and 0.01% for cadmium, or qualify for an exemption to above limits as defined in the Annex of the EU RoHS Directive. Note that any exemptions taken in this case would not include application specific exemptions (e.g. lead in solder for servers) as TE cannot determine where component products will be used.

Additionally, the part numbers that are identified as 5 of 6 compliant meet the material limits described above, except that these products have lead in the solderable interface only. These products may be suitable for use in an application that has an exemption for the use of lead in solder (e.g. servers, network infrastructure, etc).

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05 September 2012

中国电子信息产品环境信息  
China EIP Environmental Information



Restricted Materials Above Threshold

电子元件 (Electronic Component) 1711000-3	有毒有害物质或元素 Hazardous Substance					
	铅 (Pb)	汞 (Hg)	镉 (Cd)	六价铬 (Cr6)	多溴联苯 (PBB)	多溴二苯醚 (PBDE)
电子元件 (Electronic Component)	X	O	O	O	O	O

O: 表示该部件内有有毒有害物质含量在 SJ/T 11363-2006 标准规定的限量要求以下  
Indicates that the concentration of the hazardous substance in the part is below the relevant threshold of the SJ/T 1136 3-2006 standard.

X: 表示该部件内有有毒有害物质含量超出 SJ/T 11363-2006 标准规定的限量要求  
Indicates that the concentration of the hazardous substance in the part is above the relevant threshold of the SJ/T 1136 3-2006 standard.

Description for part 1711000-3:

INSERT 4x RJ45 TEL /B

The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hex chrome, mercury, PBB, PBDE, and 0.01% for cadmium, or qualify for an exemption to above limits as defined in the Annex of the EU RoHS Directive. Note that any exemptions taken in this case would not include application specific exemptions (e.g. lead in solder for servers) as TE cannot determine where component products will be used.

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## Statement of Compliance

### Requested Part

05 September 2012

1711001-5

( Part 1 of 1)

INSERT 4x RJ45 TEL 100ohm term /W

Status: Active

EU RoHS/ELV Code: 5 of 6 EU RoHS/ELV Compliant

Solder Process Capability Code: Not applicable for solder process capability

China RoHS:  Restricted Materials Above Threshold

Exemptions: 7(x) - Pb-Used for ELV, 5/6 parts

REACH Oct 2008 SvHC Compliance: Not reviewed for REACH October 2008 SvHC(s)

REACH Jan/Mar 2010 SvHC Compliance: Not reviewed for REACH Jan/Mar 2010 SvHC(s)

REACH June 2010 SvHC Compliance: Contains no REACH June 2010 SvHC(s)

REACH Dec 2010 SvHC Compliance: Contains no REACH December 2010 SvHC(s)

REACH June 2011 SvHC Compliance: Not reviewed for REACH June 2011 SvHC(s)

REACH December 2011 SvHC Compliance: Not reviewed for REACH December 2011 SvHC(s)

REACH June 2012 SvHC Compliance: Not reviewed for REACH June 2012 SvHC(s)

Halogen Content: Not Yet Reviewed for halogen content

David R. Bender

Director, Product Compliance

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The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hex chrome, mercury, PBB, PBDE, and 0.01% for cadmium, or qualify for an exemption to above limits as defined in the Annex of the EU RoHS Directive. Note that any exemptions taken in this case would not include application specific exemptions (e.g. lead in solder for servers) as TE cannot determine where component products will be used.

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05 September 2012

中国电子信息产品环境信息  
China EIP Environmental Information



Restricted Materials Above Threshold

电子元件 (Electronic Component) 1711001-5	有毒有害物质或元素 Hazardous Substance					
	铅 (Pb)	汞 (Hg)	镉 (Cd)	六价铬 (Cr6)	多溴联苯 (PBB)	多溴二苯醚 (PBDE)
电子元件 (Electronic Component)	X	O	O	O	O	O

O: 表示该部件内有有毒有害物质含量在 SJ/T 11363-2006 标准规定的限量要求以下  
Indicates that the concentration of the hazardous substance in the part is below the relevant threshold of the SJ/T 1136 3-2006 standard.

X: 表示该部件内有有毒有害物质含量超出 SJ/T 11363-2006 标准规定的限量要求  
Indicates that the concentration of the hazardous substance in the part is above the relevant threshold of the SJ/T 1136 3-2006 standard.

Description for part 1711001-5:

INSERT 4x RJ45 TEL 100ohm term /W

The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hex chrome, mercury, PBB, PBDE, and 0.01% for cadmium, or qualify for an exemption to above limits as defined in the Annex of the EU RoHS Directive. Note that any exemptions taken in this case would not include application specific exemptions (e.g. lead in solder for servers) as TE cannot determine where component products will be used.

Additionally, the part numbers that are identified as 5 of 6 compliant meet the material limits described above, except that these products have lead in the solderable interface only. These products may be suitable for use in an application that has an exemption for the use of lead in solder (e.g. servers, network infrastructure, etc).

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information provided by our suppliers. This information is subject to change.



## Statement of Compliance

### Requested Part

05 September 2012

1711001-1

( Part 1 of 1)

INSERT 4x RJ45 TEL 100ohm term /A

Status: Active

EU RoHS/ELV Code: 5 of 6 EU RoHS/ELV Compliant

Solder Process Capability Code: Not applicable for solder process capability

China RoHS:  Restricted Materials Above Threshold

Exemptions: 7(x) - Pb-Used for ELV, 5/6 parts

REACH Oct 2008 SvHC Compliance: Not reviewed for REACH October 2008 SvHC(s)

REACH Jan/Mar 2010 SvHC Compliance: Not reviewed for REACH Jan/Mar 2010 SvHC(s)

REACH June 2010 SvHC Compliance: Contains no REACH June 2010 SvHC(s)

REACH Dec 2010 SvHC Compliance: Contains no REACH December 2010 SvHC(s)

REACH June 2011 SvHC Compliance: Not reviewed for REACH June 2011 SvHC(s)

REACH December 2011 SvHC Compliance: Not reviewed for REACH December 2011 SvHC(s)

REACH June 2012 SvHC Compliance: Not reviewed for REACH June 2012 SvHC(s)

Halogen Content: Not Yet Reviewed for halogen content

David R. Bender

Director, Product Compliance

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05 September 2012

中国电子信息产品环境信息  
China EIP Environmental Information



Restricted Materials Above Threshold

电子元件 (Electronic Component) 1711001-1	有毒有害物质或元素 Hazardous Substance					
	铅 (Pb)	汞 (Hg)	镉 (Cd)	六价铬 (Cr6)	多溴联苯 (PBB)	多溴二苯醚 (PBDE)
电子元件 (Electronic Component)	X	O	O	O	O	O

O: 表示该部件内有有毒有害物质含量在 SJ/T 11363-2006 标准规定的限量要求以下  
Indicates that the concentration of the hazardous substance in the part is below the relevant threshold of the SJ/T 1136 3-2006 standard.

X: 表示该部件内有有毒有害物质含量超出 SJ/T 11363-2006 标准规定的限量要求  
Indicates that the concentration of the hazardous substance in the part is above the relevant threshold of the SJ/T 1136 3-2006 standard.

Description for part 1711001-1:

INSERT 4x RJ45 TEL 100ohm term /A

The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hex chrome, mercury, PBB, PBDE, and 0.01% for cadmium, or qualify for an exemption to above limits as defined in the Annex of the EU RoHS Directive. Note that any exemptions taken in this case would not include application specific exemptions (e.g. lead in solder for servers) as TE cannot determine where component products will be used.

Additionally, the part numbers that are identified as 5 of 6 compliant meet the material limits described above, except that these products have lead in the solderable interface only. These products may be suitable for use in an application that has an exemption for the use of lead in solder (e.g. servers, network infrastructure, etc).

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## Statement of Compliance

### Requested Part

05 September 2012

1711001-3

( Part 1 of 1)

INSERT 4x RJ45 TEL 100ohm term /B

Status: Active

EU RoHS/ELV Code: 5 of 6 EU RoHS/ELV Compliant

Solder Process Capability Code: Not applicable for solder process capability

China RoHS:  Restricted Materials Above Threshold

Exemptions: 7(x) - Pb-Used for ELV, 5/6 parts

REACH Oct 2008 SvHC Compliance: Not reviewed for REACH October 2008 SvHC(s)

REACH Jan/Mar 2010 SvHC Compliance: Not reviewed for REACH Jan/Mar 2010 SvHC(s)

REACH June 2010 SvHC Compliance: Contains no REACH June 2010 SvHC(s)

REACH Dec 2010 SvHC Compliance: Contains no REACH December 2010 SvHC(s)

REACH June 2011 SvHC Compliance: Not reviewed for REACH June 2011 SvHC(s)

REACH December 2011 SvHC Compliance: Not reviewed for REACH December 2011 SvHC(s)

REACH June 2012 SvHC Compliance: Not reviewed for REACH June 2012 SvHC(s)

Halogen Content: Not Yet Reviewed for halogen content

David R. Bender

Director, Product Compliance

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The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hex chrome, mercury, PBB, PBDE, and 0.01% for cadmium, or qualify for an exemption to above limits as defined in the Annex of the EU RoHS Directive. Note that any exemptions taken in this case would not include application specific exemptions (e.g. lead in solder for servers) as TE cannot determine where component products will be used.

Additionally, the part numbers that are identified as 5 of 6 compliant meet the material limits described above, except that these products have lead in the solderable interface only. These products may be suitable for use in an application that has an exemption for the use of lead in solder (e.g. servers, network infrastructure, etc).

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05 September 2012

中国电子信息产品环境信息  
China EIP Environmental Information



Restricted Materials Above Threshold

电子元件 (Electronic Component) 1711001-3	有毒有害物质或元素 Hazardous Substance					
	铅 (Pb)	汞 (Hg)	镉 (Cd)	六价铬 (Cr6)	多溴联苯 (PBB)	多溴二苯醚 (PBDE)
电子元件 (Electronic Component)	X	O	O	O	O	O
<p>O: 表示该部件内有有毒有害物质含量在 SJ/T 11363-2006 标准规定的限量要求以下 Indicates that the concentration of the hazardous substance in the part is below the relevant threshold of the SJ/T 1136 3-2006 standard.</p> <p>X: 表示该部件内有有毒有害物质含量超出 SJ/T 11363-2006 标准规定的限量要求 Indicates that the concentration of the hazardous substance in the part is above the relevant threshold of the SJ/T 1136 3-2006 standard.</p>						

Description for part 1711001-3:

INSERT 4x RJ45 TEL 100ohm term /B

The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hex chrome, mercury, PBB, PBDE, and 0.01% for cadmium, or qualify for an exemption to above limits as defined in the Annex of the EU RoHS Directive. Note that any exemptions taken in this case would not include application specific exemptions (e.g. lead in solder for servers) as TE cannot determine where component products will be used.

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## Statement of Compliance

### Requested Part

05 September 2012

1711100-5

( Part 1 of 1)

### INSERT 10/100BT & 2x TEL /W

Status: Active

EU RoHS/ELV Code: 5 of 6 EU RoHS/ELV Compliant

Solder Process Capability Code: Not applicable for solder process capability

China RoHS:  Restricted Materials Above Threshold

Exemptions: 7(x) - Pb-Used for ELV, 5/6 parts

REACH Oct 2008 SvHC Compliance: Not reviewed for REACH October 2008 SvHC(s)

REACH Jan/Mar 2010 SvHC Compliance: Not reviewed for REACH Jan/Mar 2010 SvHC(s)

REACH June 2010 SvHC Compliance: Contains no REACH June 2010 SvHC(s)

REACH Dec 2010 SvHC Compliance: Contains no REACH December 2010 SvHC(s)

REACH June 2011 SvHC Compliance: Not reviewed for REACH June 2011 SvHC(s)

REACH December 2011 SvHC Compliance: Not reviewed for REACH December 2011 SvHC(s)

REACH June 2012 SvHC Compliance: Not reviewed for REACH June 2012 SvHC(s)

Halogen Content: Not Yet Reviewed for halogen content

David R. Bender

Director, Product Compliance

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05 September 2012

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China EIP Environmental Information



Restricted Materials Above Threshold

电子元件 (Electronic Component) 1711100-5	有毒有害物质或元素 Hazardous Substance					
	铅 (Pb)	汞 (Hg)	镉 (Cd)	六价铬 (Cr6)	多溴联苯 (PBB)	多溴二苯醚 (PBDE)
电子元件 (Electronic Component)	X	O	O	O	O	O
<p>O: 表示该部件内有有毒有害物质含量在 SJ/T 11363-2006 标准规定的限量要求以下 Indicates that the concentration of the hazardous substance in the part is below the relevant threshold of the SJ/T 1136 3-2006 standard.</p> <p>X: 表示该部件内有有毒有害物质含量超出 SJ/T 11363-2006 标准规定的限量要求 Indicates that the concentration of the hazardous substance in the part is above the relevant threshold of the SJ/T 1136 3-2006 standard.</p>						

Description for part 1711100-5:

INSERT 10/100BT & 2x TEL /W

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## Statement of Compliance

### Requested Part

05 September 2012

1711100-1


( Part 1 of 1)

INSERT 10/100BT & 2x TEL /A

Status: Active

EU RoHS/ELV Code: 5 of 6 EU RoHS/ELV Compliant

Solder Process Capability Code: Not applicable for solder process capability

China RoHS:  Restricted Materials Above Threshold

Exemptions: 7(x) - Pb-Used for ELV, 5/6 parts

REACH Oct 2008 SvHC Compliance: Not reviewed for REACH October 2008 SvHC(s)

REACH Jan/Mar 2010 SvHC Compliance: Not reviewed for REACH Jan/Mar 2010 SvHC(s)

REACH June 2010 SvHC Compliance: Contains no REACH June 2010 SvHC(s)

REACH Dec 2010 SvHC Compliance: Contains no REACH December 2010 SvHC(s)

REACH June 2011 SvHC Compliance: Not reviewed for REACH June 2011 SvHC(s)

REACH December 2011 SvHC Compliance: Not reviewed for REACH December 2011 SvHC(s)

REACH June 2012 SvHC Compliance: Not reviewed for REACH June 2012 SvHC(s)

Halogen Content: Not Yet Reviewed for halogen content

David R. Bender

Director, Product Compliance

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05 September 2012

中国电子信息产品环境信息  
China EIP Environmental Information



Restricted Materials Above Threshold

电子元件 (Electronic Component) 1711100-1	有毒有害物质或元素 Hazardous Substance					
	铅 (Pb)	汞 (Hg)	镉 (Cd)	六价铬 (Cr6)	多溴联苯 (PBB)	多溴二苯醚 (PBDE)
电子元件 (Electronic Component)	X	○	○	○	○	○
<p>O: 表示该部件内有有毒有害物质含量在 SJ/T 11363-2006 标准规定的限量要求以下 Indicates that the concentration of the hazardous substance in the part is below the relevant threshold of the SJ/T 1136 3-2006 standard.</p> <p>X: 表示该部件内有有毒有害物质含量超出 SJ/T 11363-2006 标准规定的限量要求 Indicates that the concentration of the hazardous substance in the part is above the relevant threshold of the SJ/T 1136 3-2006 standard.</p>						

Description for part 1711100-1:

INSERT 10/100BT & 2x TEL /A

The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hex chrome, mercury, PBB, PBDE, and 0.01% for cadmium, or qualify for an exemption to above limits as defined in the Annex of the EU RoHS Directive. Note that any exemptions taken in this case would not include application specific exemptions (e.g. lead in solder for servers) as TE cannot determine where component products will be used.

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## Statement of Compliance

### Requested Part

05 September 2012

1711100-3


( Part 1 of 1)

INSERT 10/100BT & 2x TEL /B

Status: Active

EU RoHS/ELV Code: 5 of 6 EU RoHS/ELV Compliant

Solder Process Capability Code: Not applicable for solder process capability

China RoHS:  Restricted Materials Above Threshold

Exemptions: 7(x) - Pb-Used for ELV, 5/6 parts

REACH Oct 2008 SvHC Compliance: Not reviewed for REACH October 2008 SvHC(s)

REACH Jan/Mar 2010 SvHC Compliance: Not reviewed for REACH Jan/Mar 2010 SvHC(s)

REACH June 2010 SvHC Compliance: Contains no REACH June 2010 SvHC(s)

REACH Dec 2010 SvHC Compliance: Contains no REACH December 2010 SvHC(s)

REACH June 2011 SvHC Compliance: Not reviewed for REACH June 2011 SvHC(s)

REACH December 2011 SvHC Compliance: Not reviewed for REACH December 2011 SvHC(s)

REACH June 2012 SvHC Compliance: Not reviewed for REACH June 2012 SvHC(s)

Halogen Content: Not Yet Reviewed for halogen content

David R. Bender

Director, Product Compliance

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05 September 2012

中国电子信息产品环境信息  
China EIP Environmental Information



Restricted Materials Above Threshold

电子元件 (Electronic Component) 1711100-3	有毒有害物质或元素 Hazardous Substance					
	铅 (Pb)	汞 (Hg)	镉 (Cd)	六价铬 (Cr6)	多溴联苯 (PBB)	多溴二苯醚 (PBDE)
电子元件 (Electronic Component)	X	O	O	O	O	O
<p>O: 表示该部件内有有毒有害物质含量在 SJ/T 11363-2006 标准规定的限量要求以下 Indicates that the concentration of the hazardous substance in the part is below the relevant threshold of the SJ/T 1136 3-2006 standard.</p> <p>X: 表示该部件内有有毒有害物质含量超出 SJ/T 11363-2006 标准规定的限量要求 Indicates that the concentration of the hazardous substance in the part is above the relevant threshold of the SJ/T 1136 3-2006 standard.</p>						

Description for part 1711100-3:

INSERT 10/100BT & 2x TEL /B

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